# Dual Input, Power Path, 3A Switching Mode Charger with FG

### **General Description**

The MAX77818 is a high-performance companion PMIC for the latest smartphones and tablet computers. The PMIC includes a dual input, smart power path 3.0A switch mode charger with reverse boost capability and adapter input protection up to  $16V_{DC}$  withstand, proprietary ModelGauge<sup>TM</sup> (mg5) fuel gauge technology.

The switch mode battery charger's operating frequency is 4MHz and includes integrated, low-loss switches to provide the industry's smallest L/C size, lowest heat, and fastest battery charging programmable up to 3.0A. The charger has two inputs that accept adapter/USB (CHIN) and/or wireless type inputs (WCIN). The wireless input can simultaneously charge the battery while powering USB-OTG type accessories. The USB-OTG output provides true-load disconnect and is protected by an adjustable output current limit.

The battery charger includes smart power path and I<sup>2</sup>C adjustable settings to accommodate a wide range of battery sizes and system loads. When external power is applied from either input, battery charging is enabled. With a valid input power source (adapter or wireless charger), the BYP pin voltage is equal to the input voltage minus resistive voltage drop. During battery-only reverse boost operation, the BYP output can be regulated with the reverse boost feature and provides up to 5V at 1.5A and requires no additional inductor, allowing the MAX77818 to power USB OTG accessories.

The switching charger is designed with a special CC, CV, and die temperature regulation algorithm. ModelGauge (mg5) provides accurate battery fuel gauging without calibration and operates with extremely low battery current.

The safeout LDO drive system USB interface devices.

The MAX77818 features a  $I^{2}C$  revision 3.0-compatible serial interface that comprises a bidirectional serial data line (SDA) and a serial clock line (SCL).

### **Applications**

- Smartphones and Tablets
- Other Handheld Devices

### **Benefits and Features**

- Dual Input Switchmode Battery Charger
   Adapter/USB Input
  - Up to 13.4V Adapter Charging
  - Up to 4.0A rated, Input Current Protection (Programmable)
  - · Wireless Charging Input
    - Up to 5.9V Wireless Charging
    - Up to 1.26A, Input Current Protection (Programmable)
    - Support USB-OTG Accessories
  - Battery Charge Current, Up to 3.0A
    - No Sense Resistor
    - CC, CV, and Die Temperature Control
    - Integrated Battery True-Disconnect FET
    - R<sub>DS</sub>(ON) = 12.8mΩ
    - Rated Up to 4.5A<sub>RMS</sub>, Discharge Current Limit (Programmable)
  - Reverse Boost Capability
    - Supports USB-OTG Accessories
    - Up to 5.1V/1.5A
    - · Adjustable OCP
- ModelGauge (mg5) Battery Fuel Gauge
  - \*  $\pm 1\%$  SOC Accuracy, No Calibration Cycles, Very Low I<sub>Q</sub>
  - Time-to-Empty and Time-to-Full Prediction
- Two Safeout LDOs
- I<sup>2</sup>C Serial Interface
- 72-Bump. 3.867mm x 3.608mm WLP with 0.4mm Pitch

Ordering Information appears at end of data sheet.





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## **Absolute Maximum Ratings**

### Switching Charger

CHGIN to GND	0.3V to +16V
BYP to GND	0.3V to +16V
WCIN, PVL, AVL, BAT_SP, BATT, SYS,	
DETBATB to GND	0.3V to +6V
BST to PVL	0.3V to +16V
BST to CHGLX	0.3V to +6V
WCINOKB, INOKB to GND	0.3V to SYS+0.3V
BAT_SN, CHGPG to GND	0.3V to +0.3V
CHGLX, CHGPG Continuous Current	
SYS, BATT Continuous Current	4.5A <sub>RMS</sub>
CHGIN, BYP Continuous Current	4.0A <sub>RMS</sub>
WCIN Continuous Current	1.5A <sub>RMS</sub>
Fuel Gauge	
V <sub>BFG</sub> , to GND	0.3V to +2.2V
THMB, THM to GND	

Safeout LDOs
SAFEOUT1, SAFEOUT2 to GND0.3V to 6V
SAFEOUT1, SAFEOUT2 Continuous Current
I <sup>2</sup> C and Interface Logic
V <sub>IO</sub> to GND0.3V to +6V
SDA, SCL to GND0.3V to V <sub>IO</sub> +0.3V
INTB to GND0.3V to $V_{SYS}$ A + 0.3V
TEST_, V <sub>CCTEST</sub> , SYS_ to GND0.3V to +6V
GND_ to GND0.3V to +0.3V
Thermal Ratings
Operating Temperature Range40°C to +85°C
Junction Temperature+150°C
Storage Temperature Range65°C to +150°C
Soldering Temperature (reflow)+260°C
Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )
(derate 28.9mW/°C with 4L board, above 70°C)2.31W

CHGLX has internal clamp diodes to CHGPG and BYP. Applications that forward bias these diodes should take care not to exceed the IC's package power dissipation limits.

### Package Thermal Characteristics (Note 1)

#### WLP

Junction-to-Ambient Thermal Resistance (0JA) .......34.6°C/W

**Note 1:** Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to **www.maximintegrated.com/thermal-tutorial**.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **Electrical Characteristics**

### **General Electrical Characteristics**

 $(V_{SYS} = +3.7V, C_{HGIN} = 0V, V_{IO} = 1.8V, T_A = -40^{\circ}C$  to  $+85^{\circ}C$ , unless otherwise noted. Limits are 100% production tested at  $T_A = +25^{\circ}C$ . Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Typical values are not guaranteed.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Shutdown Supply Current (DATT)		All circuits off V <sub>BATT</sub> = 3.6V		23	50	
Shutdown Supply Current (BATT)				23	50	μA
No Lood Supply Current (PATT)		Fuel gauge is on		50	100	
No Load Supply Current (BATT)		All other circuits off, V <sub>BATT</sub> = 3.6V		50	100	μA
SYS INPUT RANGE						
SYS Operating Voltage		Guaranteed by V <sub>SYSUVLO</sub> and V <sub>SYSOVLO</sub>	2.8		5	V
SYS Undervoltage Lockout Threshold		V <sub>SYS</sub> falling, 200mV hysteresis	2.45	2.5	2.55	V
SYS Overvoltage Lockout Threshold		V <sub>SYS</sub> rising, 200mV hysteresis	5.2	5.36	5.52	V

# Dual Input, Power Path, 3A Switching Mode Charger with FG

## **Electrical Characteristics (continued)**

### **General Electrical Characteristics**

 $(V_{SYS} = +3.7V, C_{HGIN} = 0V, V_{IO} = 1.8V, T_A = -40^{\circ}C$  to  $+85^{\circ}C$ , unless otherwise noted. Limits are 100% production tested at  $T_A = +25^{\circ}C$ . Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Typical values are not guaranteed.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
LOGIC AND CONTROL INPUT	1		I			
SCL, SDA Input Low Level		T <sub>A</sub> = +25°C			0.3 x V <sub>IO</sub>	V
SCL, SDA Input High Level		T <sub>A</sub> = +25°C	0.7 x V <sub>IO</sub>			V
SCL, SDA Input Hysteresis		T <sub>A</sub> = +25°C		0.05 x V <sub>IO</sub>		V
SCL, SDA Logic Input Current		V <sub>IO</sub> = 3.6V	-10		+10	μA
SCL, SDA Input capacitance				10		pF
SDA Output Low Voltage		Sinking 20mA			0.4	V
Output Low Voltage INTB		I <sub>SINK</sub> = 1mA			0.4	V
I <sup>2</sup> C-COMPATIBLE INTERFACE TIM	ING FOR STA	NDARD, FAST, AND FAST-MODE P	LUS (Note 2)			
Clock Frequency	f <sub>SCL</sub>				1000	kHz
Hold Time (Repeated) START Condition	<sup>t</sup> HD;STA		0.26			μs
CLK Low Period	tLOW		0.5			μs
CLK High Period	thigh		0.26			μs
Setup Time Repeated START Condition	t <sub>SU;STA</sub>		0.26			μs
DATA Hold Time	t <sub>HD:DAT</sub>		0			μs
DATA Valid Time	t <sub>VD:DAT</sub>				0.45	μs
DATA Valid Acknowledge Time	t <sub>VD:ACK</sub>				0.45	μs
DATA Setup Time	t <sub>SU;DAT</sub>		50			ns
Setup Time for STOP Condition	<sup>t</sup> su;sто		0.26			μs
Bus Free Time Between STOP and START	<sup>t</sup> BUF		0.5			μs
Pulse Width of Spikes that Must Be Suppressed by the Input Filter		(Note 3)		50		ns

# Dual Input, Power Path, 3A Switching Mode Charger with FG

## **Electrical Characteristics (continued)**

### **General Electrical Characteristics**

 $(V_{SYS} = +3.7V, C_{HGIN} = 0V, V_{IO} = 1.8V, T_A = -40^{\circ}C$  to  $+85^{\circ}C$ , unless otherwise noted. Limits are 100% production tested at  $T_A = +25^{\circ}C$ . Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Typical values are not guaranteed.)

PARAMETER	SYMBOL	CONDITIONS	0	C <sub>B</sub> = 100p	F	
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
I <sup>2</sup> C-COMPATIBLE INTERFACE TIN	ING FOR HS MO	DE (Note 2)	·			
Clock Frequency	f <sub>SCL</sub>				3.4	MHz
Setup Time Repeated START Condition	<sup>t</sup> SU;STA		160			ns
Hold Time (Repeated) START Condition	<sup>t</sup> HD;STA		160			ns
CLK Low Period	t <sub>LOW</sub>		160			ns
CLK High Period	thigh		60			ns
DATA Setup time	t <sub>SU;DAT</sub>		10			ns
DATA Hold Time	t <sub>HD:DAT</sub>		0			ns
SCL Rise Time	t <sub>RCL</sub>	T <sub>A</sub> = +25°C	10		40	ns
Rise Time of SCL Signal After a Repeated START condition and After an Acknowledge Bit	<sup>t</sup> RCL1	T <sub>A</sub> = +25°C	10		80	ns
SCL Fall Time	t <sub>FCL</sub>	T <sub>A</sub> = +25°C	10		40	ns
SDA Rise Time	t <sub>RDA</sub>	T <sub>A</sub> = +25°C	10		80	ns
SDA Fall Time	t <sub>FDA</sub>	T <sub>A</sub> = +25°C			80	ns
Setup Time for STOP Condition	<sup>t</sup> su;sто		160			ns
Pulse Width of Spikes that Must be Suppressed by the Input Filter				10		ns

# Dual Input, Power Path, 3A Switching Mode Charger with FG

## **Switching Charger Electrical Characteristics**

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
CHGIN INPUT		•				
CHGIN Operating Voltage Range		Operating voltage	3.2		V <sub>OVLO</sub>	V
WCIN Operating Voltage Range		Operating voltage	3.2		V <sub>OVLO</sub>	V
CHGIN Overvoltage Threshold (Note 4)	V <sub>CHGIN-OVLO</sub>	V <sub>CHGIN</sub> rising 13.4 13.7		14	V	
WCIN Overvoltage Threshold (Note 4)	Vwcin-ovlo	V <sub>WCIN</sub> rising	5.9		6	V
WCIN Overvoltage Threshold Hysteresis	VWCINH-OVLO	V <sub>WCIN</sub> falling		100		mV
CHGIN Overvoltage Threshold Hysteresis	V <sub>CHGINH-OVLO</sub>	V <sub>CHGIN</sub> falling		300		mV
	Ŧ	V <sub>WCIN/BUS_DET</sub> rising, 100mV overdrive, not production tested		10		us
WCIN/CHGIN Overvoltage Delay	T <sub>D-OVLO</sub>	V <sub>WCIN/BUS_DET</sub> falling, 100mV overdrive, not production tested		20		US
WCIN/CHGIN to GND Minimum Turn-On Threshold Range (Note 4)	Vwcin/chgin_ UVLO	V <sub>CHGIN</sub> rising, 100mV hysteresis, programmable at 4.5V, 4.9V, 5.0V, 5.1V, WCIN input is disabled when valid CHGIN input is detected	4.5		5.1	V
WCIN/CHGIN to GND Minimum Turn-On Threshold Accuracy	V <sub>WCIN/CHGIN</sub> _ UVLO	V <sub>WCIN/CHGIN</sub> rising, 4.5V setting	4.4	4.5	4.6	V
WCIN/CHGIN to SYS Minimum Turn-On Threshold (Note 4)	V <sub>WCIN</sub> / CHGIN2SYS	V <sub>CHGIN</sub> rising, 50mV hysteresis, WCIN input is disabled when valid CHGIN input is detected	V <sub>SYS</sub> + 0.12	V <sub>SYS</sub> + 0.20	V <sub>SYS</sub> + 0.28	V
WCIN/CHGIN Turn-On Threshold Delay	T <sub>D-UVLO</sub>	Not production tested		10		us
WCIN/CHGIN Adaptive Current Regulation Threshold Range (Note 5)	V <sub>WCIN/</sub> CHGIN_REG	Programmable at 4.3V, 4.7V, 4.8V, 4.9V	4.3		4.9	V
WCIN/CHGIN Adaptive Voltage Regulation Threshold Accuracy	V <sub>WCIN/</sub> CHGIN_REG	4.9V setting	4.8	4.9	5	V
CHGIN Current-Limit Range		Programmable, 500mA default, factory programmable option of 100mA, production tested at 100mA, 500mA, 1000mA, 1800mA, 4000mA settings only	0.1		4	A
WCIN Current-Limit Range		Programmable, 500mA default, factory programmable option of 100mA, production tested at 100mA, 250mA, 500mA, 1000mA settings only	0.06		1.26	A

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## **Switching Charger Electrical Characteristics (continued)**

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
		$V_{WCIN/CHGIN}$ = 2.4V, the input is undervoltage and $R_{INSD}$ is the only loading		0.075		
WCIN or CHGIN Supply Current	I <sub>IN</sub>	V <sub>WCIN/CHGIN</sub> = 5.0V, charger disabled		0.17	0.5	mA
		$V_{WCIN/CHGIN} = 5.0V$ , charger enabled, $V_{SYS} = V_{BATT} = 4.5V$ , (no switching, battery charged)		2.7	4	-
		$V_{WCIN}$ or $V_{CHGIN}$ = 5.0V, charger enabled, $V_{BATT}$ = 3.8V, 100mA input current setting, $T_A$ = +25°C	90	102	108	
VWCIN or VCHGIN Input Current		$V_{WCIN}$ or $V_{CHGIN}$ = 5.0V, charger enabled, $V_{BATT}$ = 3.8V, 500mA Input current setting, $T_A$ = +25°C	462.5	487.5	500	
Limit	IINLIMIT	$V_{WCIN}$ or $V_{CHGIN}$ = 5.0V, charger enabled, $V_{BATT}$ = 3.8V, 1000mA Input current setting, $T_A$ = +25°C	950	975	1000	mA
		$V_{WCIN}$ or $V_{CHGIN}$ = 5.0V, charger enabled, $V_{BATT}$ = 3.8V, 1000mA input current setting, $T_A$ = 0°C to +85°C	926	975	1024	
		$V_{CHGIN}$ = 5.0V, charger enabled, $V_{BATT}$ = 3.8V, 1800mA input current setting, $T_A$ = +25°C	1710	1755	1800	
		$V_{CHGIN}$ = 5.0V, charger enabled, $V_{BATT}$ = 3.8V, 1800mA input current setting, T <sub>A</sub> = 0°C to +85°C	1667	1755	1843	
VCHGIN Input Current Limit	IINLIMIT	$V_{CHGIN}$ = 5.0V, charger enabled, $V_{BATT}$ = 3.8V, 4000mA input current setting, $T_A$ = +25°C	3800	3900	4000	mA
		$V_{CHGIN}$ = 5.0V, charger enabled, $V_{BATT}$ = 3.8V, 4000mA input current setting, $T_A$ = 0°C to +85°C	3705	3900	4095	
WCIN, CHGIN Self-Discharge Down to UVLO Time	t <sub>INSD</sub>	Time required for the charger input to cause a $10\mu$ F input capacitor to decay from 6.0V to 4.3V.		100		ms
WCIN, CHGIN Input Self-Discharge Resistance	R <sub>INSD</sub>	For CHGIN, this resistor is disconnected from the CHGIN pin during MUIC microphone mode		35		kΩ
WCINOK/CHGINOK to Start Switching	<sup>t</sup> START			150		ms

# Dual Input, Power Path, 3A Switching Mode Charger with FG

## **Switching Charger Electrical Characteristics (continued)**

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
SWITCH IMPEDANCES AND LEA	KAGE CURRENTS						
CHGIN to BYP Resistance	R <sub>IN2BYP</sub>	Bidirectional			0.0144	0.04	Ω
WCIN to BYP Resistance	R <sub>WCIN2BYP</sub>				0.093	0.26	Ω
CHGLX High-Side Resistance	R <sub>HS</sub>				0.0327	0.1	Ω
CHGLX Low-Side Resistance	R <sub>LS</sub>				0.0543	0.14	Ω
BATT to SYS Dropout Resistance	R <sub>BAT2SYS</sub>				0.0128	0.04	Ω
CHGIN to BATT Dropout Resistance	P	Calculation estimates a resistance (R <sub>L</sub> )	a 0.04Ω inductor		0.0999		Ω
	R <sub>IN2BAT</sub> R <sub>IN2BAT</sub> = R <sub>IN2BYP</sub> + R <sub>HS</sub> +R <sub>L</sub> + R <sub>BAT2SYS</sub>		R <sub>HS</sub> +R <sub>L</sub> +	0.0999			12
CHGLX Leakage Current	CHGLX = CHGPG or T	T <sub>A</sub> = +25°C		0.01	10	μA	
		BYP	T <sub>A</sub> = +85°C		1		μA
DST Lookago Current		$\lambda = $	T <sub>A</sub> = +25°C		0.01	10	μA
BST Leakage Current		V <sub>BST</sub> = 5.5V	T <sub>A</sub> = +85°C		1		μA
BYP Leakage Current		V <sub>BYP</sub> = 5.5V, V <sub>CHGIN</sub> = 0V, V <sub>CHGLX</sub> = 0V,	T <sub>A</sub> = +25°C		0.01	10	μA
DIF Leakage Current		charger disabled	T <sub>A</sub> = +85°C		1		μA
WCINI Lookago Current		$V_{BYP} = 0V,$	T <sub>A</sub> = +25°C		0.01		μA
WCIN Leakage Current		V <sub>CHGIN</sub> = 0V, V <sub>WCIN</sub> = 5.5V	T <sub>A</sub> = +85°C		1		μA
SYS Leakage Current		V <sub>SYS</sub> = 0V, V <sub>BATT</sub> = 4.2V,	T <sub>A</sub> = +25°C		0.01	10	μA
STO Leanage Guiterit	kage Current		T <sub>A</sub> = +85°C		1		μA

# Dual Input, Power Path, 3A Switching Mode Charger with FG

## **Switching Charger Electrical Characteristics (continued)**

PARAMETER	SYMBOL	SYMBOL CONDITIONS			TYP	MAX	UNITS	
		V <sub>CHGIN</sub> = 0V, V <sub>SYS</sub> = 0V,	T <sub>A</sub> = +25°C		20	30	μA	
		V <sub>BATT</sub> = 4.2V, QBAT is off	T <sub>A</sub> = +85°C		20		μA	
		V <sub>CHGIN</sub> = 0V, V <sub>BATT</sub> = 4.2V, QBAT is on, main-battery	T <sub>A</sub> = +25°C		15.3		μA	
	I <sub>MBAT</sub>	overcurrent protection disabled	T <sub>A</sub> = +85°C		15.3		μA	
BATT Quiescent Current (I <sub>SYS</sub> = 0A, I <sub>BYP</sub> = 0A )		V <sub>CHGIN</sub> = 0V, V <sub>BATT</sub> = 4.2V, QBAT is on, main-battery	T <sub>A</sub> = +25°C		20		μA	
		overcurrent protection enabled	T <sub>A</sub> = +85°C		20		μA	
		$V_{SYS} = 4.2V,$	T <sub>A</sub> = +25°C		0.01	10	μA	
		V <sub>BATT</sub> = 0V, charger disabled	T <sub>A</sub> = +85°C		1		μA	
		$V_{CHGIN} = 5V,$ $V_{BATT} = 4.2V, QBAT$ is off, main-battery	T <sub>A</sub> = +25°C		3	10	μΑ	
	IMBDN	overcurrent protection disabled, Charger is enabled but in its done mode	T <sub>A</sub> = +85°C		3		μΑ	
CHARGER DC-DC BUCK			1	T			1	
Minimum On-Time	ton-min				75		ns	
Minimum Off-Time	tOFF				75		ns	
		T <sub>A</sub> = 0°C to +85°C	I <sub>LIM</sub> = 00 (3.00A out)	4.15	5.05	5.95		
		$I_{ND} = 0 (0.47 \mu H)$ inductor option)	I <sub>LIM</sub> = 01 (2.75A out)		4.75		A	
		Production tested at I <sub>LIM</sub> = 00 setting	I <sub>LIM</sub> = 10 (2.50A out)		4.45			
Current Limit (Note 6)	hur	(Note 7)	I <sub>LIM</sub> = 11 (2.25A out)		4.15			
	ILIM	$T_A = 0^{\circ}C$ to +85°C	I <sub>LIM</sub> = 00 (3.00A out)		4.60			
		$I_{ND} = 1$ (1.0µH inductor option)	I <sub>LIM</sub> = 01 (2.75A out)		4.30			
		Production tested at I <sub>LIM</sub> = 11 setting (Note 7)	I <sub>LIM</sub> = 10 (2.50A out)		4.00		A	
			I <sub>LIM</sub> = 11 (2.25A out)	3.00	3.70	4.40		

# Dual Input, Power Path, 3A Switching Mode Charger with FG

## **Switching Charger Electrical Characteristics (continued)**

PARAMETER	SYMBOL	CONDI	TIONS	MIN	TYP	MAX	UNITS
REVERSE BOOST		1					
BYP Voltage Adjustment Range		2.5V < V <sub>BATT</sub> < 4.5V 3V to 5.75V, product 5.0V and 5.75V settin	on tested at 3V,	3		5.75	V
Reverse Boost Quiescent Current	I <sub>BYP</sub>	Not switching: output above its target regu			1150		μA
Reverse Boost BYP Voltage in OTG Mode	V <sub>BYP.OTG</sub>	5.1V setting		4.94	5.1	5.26	V
CHGIN Voltage in OTG Mode	V <sub>CHGIN.OTG</sub>	Mode = 0x05 or 0x0F on, VCHGIN_REG = + RDSCHGIN < 300r current ≤ 450mA	4.9V, RIN2WCIN	4.75			V
			OTG_ILIM = 00	500		550	mA
		3.4V < V <sub>BATT</sub>	OTG_ILIM = 01	900		990	mA
CHGIN Output Current Limit	ICHGIN.OTG.LIM	< 4.5V, T <sub>A</sub> = +25°C	OTG_ILIM = 10	1200		1320	mA
			OTG_ILIM=11	1500		1650	mA
Reverse Boost Output Voltage		Discontinuous inductor current (i.e., skip mode)			±150		mV
Ripple		Continuous inductor current			±150		mV
CHARGER							
BATT Regulation Voltage Range	V <sub>BATTREG</sub>	Programmable in 250 production tested at 2 only.		3.65		4.7	V
		0.05\/.end.4.7\/	T <sub>A</sub> = +25°C	-0.75		+0.75	%
BATT Regulation Voltage Accuracy		3.65V and 4.7V settings	T <sub>A</sub> = 0°C to +85°C	-1		+1	%
Fast-Charge Current Program Range		0A to 3.0A in 50mA s tested at 500,1000, 2 settings		0		3	A
		Programmed currents ≥ 500mA, V <sub>BATT</sub> > V <sub>SYSMIN</sub> (short mode),	T <sub>A</sub> = +25°C	-2.5		+2.5	%
Fast-Charge Current Accuracy		production tested at 500mA, 800mA, 1000mA, 2000mA, 3000mA settings	T <sub>A</sub> = 0°C to +85°C	-5		+5	%
		Programmed current < V <sub>SYSMIN</sub> (LDO mo test at 800mA		-10		+10	%

# Dual Input, Power Path, 3A Switching Mode Charger with FG

## **Switching Charger Electrical Characteristics (continued)**

PARAMETER	SYMBOL	CC	ONDITIONS	MIN	TYP	MAX	UNITS
			Programmed for 3.0A	2925	3000	3075	mA
Fact Obarra Querrate		T <sub>A</sub> = +25°C,	Programmed for 2.0A	1950	2000	2050	mA
Fast-Charge Currents	I <sub>FC</sub>	V <sub>BATT</sub> > V <sub>SYSMIN</sub>	Programmed for 1.0A	975	1000	1025	mA
		Programmed for 0.5A	487.5	500	512.5	mA	
Low-Battery Prequalification Threshold	V <sub>PQLB</sub>	V <sub>BATT</sub> rising		2.8	2.9	3	V
Dead-Battery Prequalification Threshold	V <sub>PQDB</sub>	V <sub>BATT</sub> rising		1.9	2	2.1	V
Prequalification Threshold Hysteresis	V <sub>PQ-H</sub>	Applies to both	$V_{\mbox{PQLB}}$ and $V_{\mbox{PQDB}}$		100		mV
Low-Battery Prequalification Charge Current	I <sub>PQLB</sub>	Default setting	= disabled	75	100	140	mA
Dead-Battery Prequalification Charge Current	I <sub>PQDB</sub>			40	55	80	mA
Charger Restart Threshold Range	V <sub>RSTRT</sub>	Adjustable, 100 also be disable	), 150, and 200; it can d	100	150	200	mV
Charger Restart Deglitch Time		10mV overdrive	e, 100ns rise time		130		ms
Top-Off Current Program Range		Programmable 8 steps.	from 100 to 350mA in	100		350	mA
Top-Off Current Accuracy		Gain				5	%
(Note 8)		Offset				20	mA
Charge Termination Deglitch Time	<sup>t</sup> TERM	2mV overdrive, 100ns rise/fall time			30		ms
Charger State Change Interrupt Deglitch Time	tscidg	Excludes transition to timer fault state, watchdog timer state			30		ms
Charger Soft-Start Time	t <sub>SS</sub>				1.5		ms

# Dual Input, Power Path, 3A Switching Mode Charger with FG

## **Switching Charger Electrical Characteristics (continued)**

PARAMETER	SYMBOL	CON	IDITIONS	MIN	TYP	MAX	UNITS
SMART POWER SELECTOR							
		I <sub>BATT</sub> = 10mA			30		mV
BATT to SYS Reverse Regulation	V <sub>BSREG</sub>	I <sub>BATT</sub> = 1A			60		mV
Voltage	*BSREG	Load regulation d regulation mode	uring the reverse		30		mV/A
Minimum SYS Voltage Accuracy	V <sub>SYSMIN</sub>	Programmable from 3.4V to 3.7V in 100mV steps, $V_{BATT}$ = 2.8V, tested at 3.4V and 3.7V settings		-3		3	%
Maximum SYS Voltage	V	The maximum system voltage: VSYSMAX = VBATREG + RBAT2SYS X IBATT	V <sub>BATREG</sub> = 4.2V, I <sub>BATT</sub> = 3.0A		4.245	4.32	V
	V <sub>SYSMAX</sub>	The maximum system voltage: V <sub>SYSMAX</sub> = V <sub>BATREG</sub> + R <sub>BAT2SYS</sub> x I <sub>BATT</sub> .	V <sub>BATREG</sub> = 4.7V, I <sub>BATT</sub> = 3.0A		4.745	4.82	v
WATCHDOG TIMER							
Watchdog Timer Period	t <sub>WD</sub>			80			s
Watchdog Timer Accuracy				-20	0	+20	%
CHARGE TIMER							
Prequalification Time	t <sub>PQ</sub>	Applies to both lo prequalification and prequalification m	nd dead-battery		35		min
Fast-Charge Constant Current + Fast-Charge Constant Voltage Time	t <sub>FC</sub>	Adjustable from 4 steps including a	hrs to 16hrs in 2 hour disable setting		8		hrs
Top-Off Time	t <sub>TO</sub>	Adjustable from 0min to 70min in 10min steps			30		min
Timer Accuracy				-20		+20	%
AVL FILTER							
Internal AVL Filter Resistance					12.5		Ω

# Dual Input, Power Path, 3A Switching Mode Charger with FG

## **Switching Charger Electrical Characteristics (continued)**

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
THERMAL FOLDBACK						1
Junction Temperature Thermal Regulation Loop Setpoint Program Range	T <sub>JREG</sub>	Junction temperature when charge current is reduced. Programmable from +85°C to +130°C in 15°C steps, default value is +100°C	85		130	°C
Thermal Regulation Gain	A <sub>TJREG</sub>	The charge current is decreased 6.7% of the fast charge current setting for every degree that the junction temperature exceeds the thermal regulation temperature. This slope ensures that the full-scale current of 3.0A is reduced to 0A by the time the junction temperature is 20°C above the programmed loop set point. For lower programmed charge currents such as 500mA, this slope is valid for charge current reductions down to 100mA; below 100mA the slope becomes shallower but the charge current still reduced to 0A if the junction temperature is 20°C above the programmed loop set point.		-150		mA/°C
BATTERY OVERCURRENT PROT	ECTION					
Battery Overcurrent Threshold Range	IBOVCR	Programmable from 3.0A to 4.5A in 0.25A steps, can be disabled	3		4.5	A
Battery Overcurrent Debounce Time	<sup>t</sup> BOVRC	This is the response time for generating the overcurrent interrupt flag	3	6	10	ms
Battery Overcurrent Protection Quiescent Current	IBOVRC			3 + I <sub>BATT</sub> /22000		μA
System Power-Up Current	ISYSPU		35	50	80	mA
System Power-Up Voltage	V <sub>SYSPU</sub>	V <sub>SYS</sub> rising, 100mV hysteresis	2	2.1	2.2	V
System Power-Up Response Time	<sup>t</sup> syspu	Time required for circuit to activate from an unpowered state (i.e., main-battery hot insertion)		1		μs
SYSTEM SELF DISCHARGE WITH	H NO POWER					
BATT Self-Discharge Resistor				600		Ω
SYS Self-Discharge Resistor				600		Ω
Self-Discharge Latch Time				300		ms

# Dual Input, Power Path, 3A Switching Mode Charger with FG

## **Switching Charger Electrical Characteristics (continued)**

 $(V_{CHGIN} = 5V, V_{BATT} = 4.2V, T_A = -40^{\circ}C$  to +85°C, unless otherwise noted. Typical values are at  $T_A = 25^{\circ}C$ . Fast-charge current is set for 1.5A, done current is set for 150mA. Limits are 100% production tested at  $T_A = +25^{\circ}C$ . Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Typical values are not guaranteed.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
DETBATB, INOKB, WCINOKB							
DETBATB Logic Threshold	V <sub>IH</sub>	4% hysterisis			0.8 x V <sub>IO</sub>		V
Logic Input Leakage Current	IDETBATB				0.1	1	μA
Output Low Voltage INOKB, WCINOKB		I <sub>SINK</sub> = 1mA				0.4	V
Output High Leakage INOKB,			T <sub>A</sub> = +25°C	-1	0	+1	μA
WCINOKB		$V_{SYS} = 5.5V$ T,	T <sub>A</sub> = +85°C		0.1		μA

### **Safeout LDOs Electrical Characteristics**

 $(V_{SYS} = 2.8V \text{ to } 4.5V, T_A = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C}$ , typical values are at  $T_A = +25^{\circ}\text{C}$ , unless otherwise noted. Limits are 100% production tested at  $T_A = +25^{\circ}\text{C}$ . Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Typical values are not guaranteed.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
SAFEOUT1							
		5V < V <sub>CHGIN</sub> < 5.5V, I <sub>OUT</sub> = 10mA, SAFEOUT1 = 01 (default)	4.8	4.9	5	V	
Output Voltage (Default On)		SAFEOUT1 = 00		4.85		V	
		SAFEOUT1 = 10		4.95		V	
		SAFEOUT1 = 11		3.3		V	
Maximum Output Current			60			mA	
Output Current Limit			60	150	320	mA	
Dropout Voltage		V <sub>CHGIN</sub> = 5V, I <sub>OUT</sub> = 60mA		120		mV	
Load Regulation		V <sub>CHGIN</sub> = 5.5V, 30µA < I <sub>OUT</sub> < 30mA		50		mV	
Quiescent Supply Current		Not production tested		72		μA	
Output Capacitor for Stable Operation (Note 9)		0μA < I <sub>OUT</sub> < 30mA, MAX ESR = 50mΩ		1		μF	
Minimum Output Capacitor for Stable Operation (Note 9)		0μA < I <sub>OUT</sub> < 30mA, MAX ESR = 50mΩ		0.7		μF	
Internal Off-Discharge Resistance				1200		Ω	

# Dual Input, Power Path, 3A Switching Mode Charger with FG

## **Safeout LDOs Electrical Characteristics (continued)**

 $(V_{SYS} = 2.8V \text{ to } 4.5V, T_A = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C}$ , typical values are at  $T_A = +25^{\circ}\text{C}$ , unless otherwise noted. Limits are 100% production tested at  $T_A = +25^{\circ}\text{C}$ . Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Typical values are not guaranteed.))

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
SAFEOUT2							
		5V < V <sub>CHGIN</sub> < 5.5V, I <sub>OUT</sub> = 10mA, SAFEOUT2 = 01 (default)	4.8	4.9	5	V	
Output Voltage (Default Off)		SAFEOUT2 = 00		4.85		V	
-		SAFEOUT2 = 10		4.95		V	
-		SAFEOUT2 = 11		3.3		V	
Maximum Output Current			60			mA	
Output Current Limit			60	150	320	mA	
Dropout Voltage		V <sub>CHGIN</sub> = 5V, I <sub>OUT</sub> = 60mA		120		mV	
Load Regulation		V <sub>CHGIN</sub> = 5.5V, 30µA < I <sub>OUT</sub> < 30mA		50		mV	
Quiescent Supply Current		Not production tested		72		μA	
Output Capacitor for Stable Operation (Note 9)		0μA < I <sub>OUT</sub> < 30mA, MAX ESR = 50mΩ		1		μF	
Minimum Output Capacitor for Stable Operation (Note 9)		0FA < I <sub>OUT</sub> < 30mA, MAX ESR = 50mΩ		0.7		μF	
Internal Off-Discharge Resistance				1200		Ω	

Note 9: Not production tested.

### **Fuel Gauge Electrical Characteristics**

 $(V_{SYS} = 2.8V \text{ to } 4.5V, T_A = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C}$ , typical values are at  $T_A = +25^{\circ}\text{C}$ , unless otherwise noted. Limits are 100% production tested at  $T_A = +25^{\circ}\text{C}$ . Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Typical values are not guaranteed.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
	I <sub>DD0</sub>	Fuel gauge shut down (Note 10)		0.5		μA
Supply Current	I <sub>DD1</sub>	Fuel gauge active, average with 7.5% ADC duty cycle (Note 10)		35	70	μA
ADC Duty Cycle	Duty			7.5		%
Parameter Capture Rate	tACQ	Period of ADC activation loop		0.1758		s
Regulator Output	V <sub>BFG</sub>		1.5	1.8	1.98	V
VOLTAGE CHANNEL						
	\/	$V_{BATT}$ = 2.8V to 4.5V, $T_A$ = +25°C	-7.5		+7.5	mV
V <sub>BATT</sub> Measurement Error	V <sub>GERR</sub>	$T_A = -40^{\circ}C$ to $+85^{\circ}C$	-20		+20	mV
V <sub>BATT</sub> Measurement Resolution	V <sub>LSB</sub>			1.25		mV
V <sub>BATT</sub> Measurement Range	V <sub>RANGE</sub>		2.8		4.98	V

# Dual Input, Power Path, 3A Switching Mode Charger with FG

## **Fuel Gauge Electrical Characteristics (continued)**

 $(V_{SYS} = 2.8V \text{ to } 4.5V, T_A = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C}, \text{ typical values are at } T_A = +25^{\circ}\text{C}, \text{ unless otherwise noted. Limits are 100% production tested at } T_A = +25^{\circ}\text{C}$ . Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Typical values are not guaranteed.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
CURRENT CHANNEL		·						
Current Measurement Resolution	I <sub>LSB</sub>				1.25		mA	
Current Measurement Range	IRANGE			-3.6		+3.6	Α	
Current Measurement Offset	IOERR	Long term average at zero input current			±0.25		mA	
Current Measurement Symmetrical Error	I <sub>SERR</sub>	(Notes 11, 12, 13)			2%		%	
		±3000mA		-150	-	+150	mA	
Current Measurement Asymmetrical Error	I <sub>AERR</sub>	±1000mA	(Notes 12, 13, 14)	-20		+20		
Asymmetrical Endi		±300mA		-9.5		+9.5		
Linear Regulator Mode Current Measurement Error		+1500mA	(Note 15)	-225		+225	mA	
	I <sub>LRERR</sub>	+100mA	(Note 15)	-40		+40		
The Deve Armony	+	V <sub>SYS</sub> = 3.7V at T <sub>A</sub> = +25°C		±1			%	
Time-Base Accuracy	t <sub>ERR</sub>	$T_{A} = -40^{\circ}C \text{ to } +85^{\circ}C$		-3.5		+3.5	/0	
THERMAL CHANNEL								
Ratiometric Measurement Accuracy, THM	T <sub>GERR</sub>	(Note 13)		-0.5		+0.5	% of full scale	
Ratiometric Measurement Resolution, THM	T <sub>LSB</sub>				0.0244		% of full scale	
THMB Output Drive	V <sub>OH_THMB</sub>	I <sub>OH_THMB</sub> = -(	).5mA	V <sub>AVL</sub> - 0.1			V	
THMB Precharge Time	<sup>t</sup> PRE_THMB				12.7		ms	
THMB Operating Range	V <sub>THMB</sub>			2.8		V <sub>AVL</sub>	V	
THMB Input Leakage	IIN_THMB	V <sub>THMB</sub> = 5V		-1		+1	μA	
THM Input leakage	I <sub>IN_THM</sub>			-1		+1	μA	

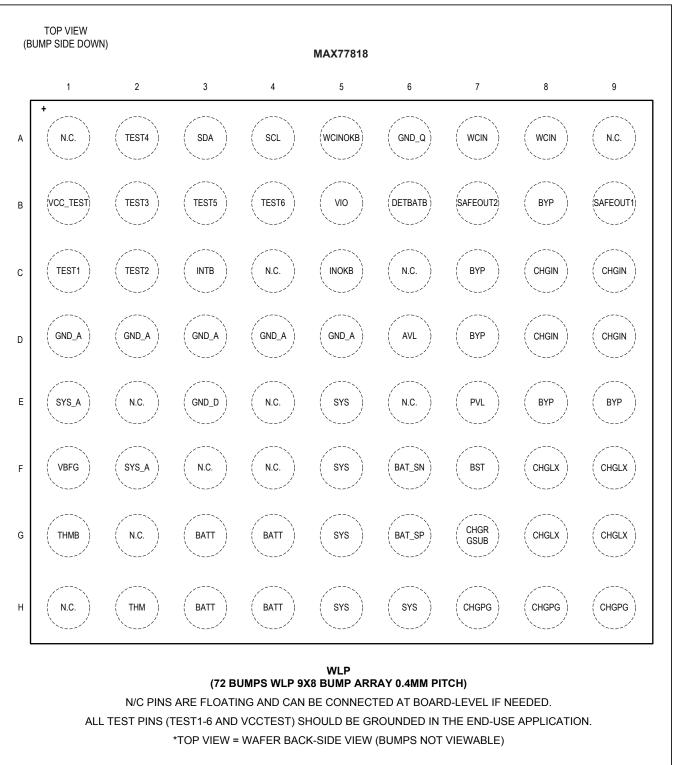
# Dual Input, Power Path, 3A Switching Mode Charger with FG

## **Electrical Characteristics (continued)**

- Note 2: Design guidance only, not tested during final test.
- Note 3: Input filters on the SDA and SCL inputs suppress noise spikes of less than 50ns.
- Note 4: The CHGIN input must be less than V<sub>OVLO</sub> and greater than both V<sub>CHGIN\_UVLO</sub> and V<sub>CHGIN2SYS</sub> for the charger to turn-on.
- Note 5: The input voltage regulation loop decreases the input current to regulate the input voltage at V<sub>CHGIN\_REG</sub>. If the input current is decreased to I<sub>CHGIN\_REG</sub> of the input voltage is below V<sub>CHGIN\_REG</sub>, then the charger input is turned off.
- **Note 6:** Production tested to  $\frac{1}{4}$  of the threshold with LPM bit = 1 ( $\frac{1}{4}$  FET configuration).
- Note 7: Production tested in charger DC-DC low-power mode (CHG\_LPM bit = 1).
- Note 8: Not production tested. Note 10: The total chip supply current includes the charger supply current in addition to the supply current for the fuel gauge.
- Note 11: Symmetrical error is the sum of odd order errors in the measured values at two inputs symmetrical around zero; for example, ISERR\_0.3A = (Error 0.3A Error -0.3A)/2/0.3A x 100.
- Note 12: Total current measurement error is the sum of the symmetrical and asymmetrical errors. Fuel gauge accuracy is sensitive to asymmetrical error but insensitive to symmetrical error.
- Note 13:Current and ratiometric measurement errors are production tested at  $V_{SYS}$  = 3.7V and guaranteed by design at  $V_{SYS}$  = 2.8V and 4.5V.
- Note 14:Asymmetrical error is the sum of even order errors in the measured values at two inputs symmetrical around zero; for example IAERR\_0.3A = (Error 0.3A + Error -0.3A)/2.
- Note 15: Total linear regulator mode current measurement error is simply the total error with respect to the input. This mode exists for a short duration when charging an empty battery, hence this error has limited consequence.

# Dual Input, Power Path, 3A Switching Mode Charger with FG

# **Pin Configuration**



# Dual Input, Power Path, 3A Switching Mode Charger with FG

# **Pin Description**

PIN	NAME	FUNCTION
A1, A9, C4, C6, E2, E4, E6, F3, F4, G2, H1	N.C.	No Connection
A2	TEST4	Test I/O Pin. Ground this pin in the application.
A3	SDA	$I^2C$ Serial Data. Add an external 2.2k $\Omega$ pullup resistor to $V_{IO}.$
A4	SCL	$I^2C$ Serial Clock. Add an external 2.2k $\Omega$ pullup resistor to $V_{IO}.$
A5	WCINOKB	Wireless Charger Input Valid, Active-Low Logic Output Flag. Open-drain, active-low output that indicates when valid voltage is present at WCIN and SYS.
A6	GND_Q	Quiet Ground. Short to GND_A and GND_D.
A7, A8	WCIN	Wireless Charger Input. $6V_{DC}$ protected input pin connected to Wireless charger power source. The wireless charger may be active during OTG mode, or disabled using the WCINSEL bit. Connect a 4.7µF/10V ceramic capacitor from WCIN to GND plane
B1	V <sub>CCTEST</sub>	Test Mux Supply. Ground this pin in the application.
B2	TEST3	Test I/O. Ground this pin in the application.
B3	TEST5	Test I/O. Ground this pin in the application.
B4	TEST6	Test I/O. Ground this pin in the application.
B5	V <sub>IO</sub>	Digital I/O Supply Input for I <sup>2</sup> C Interface.
B6	DETBATB	Battery Detection Active-Low Input. Connect this pin to the ID pin on the battery pack. If DETBATB is pulled below 80% of the externally applied $V_{IO}$ voltage, this is an indication that the battery is present and the charger starts when valid CHGIN and/or WCIN power is present. If DETBATB is driven high to VIO voltage or left unconnected, this is an indication that the battery is not present and the charger does not start. DETBATB is pulled high to $V_{IO}$ pin through an off-chip pullup resistor.
B7	SAFEOUT2	Safeout LDO2 Output. Default off. Bypass with a 1µF ceramic capacitor to GND.
B8, C7, D7, E8, E9	BYP	CHGIN Bypass. This pin can see up to OVP limit. Output of adapter Input current Limit block and input to switching charger. BYP is also the boost converter output when the charger is operating in reverse boost mode. Bypass with $2x10\mu$ F/16V ceramic capacitors from BYP to CHGPG ground plane.
В9	SAFEOUT1	Safeout LDO1 Output. Default 4.9V and on when CHGIN power is valid. Bypass with a $1\mu F$ ceramic capacitor to GND.
C1	TEST1	Test I/O. Ground this pin in the application.
C2	TEST2	Test I/O. Ground this pin in the application.
C3	INTB	Interrupt Output. Active-low, open-drain output. Add a 200k $\Omega$ pullup resistor to V <sub>IO</sub> .
C5	INOKB	Charger Input Valid, Active-Low Logic Output Flag. Open-drain output indicates when valid voltage is present at both CHGIN and SYS or WCIN and SYS.

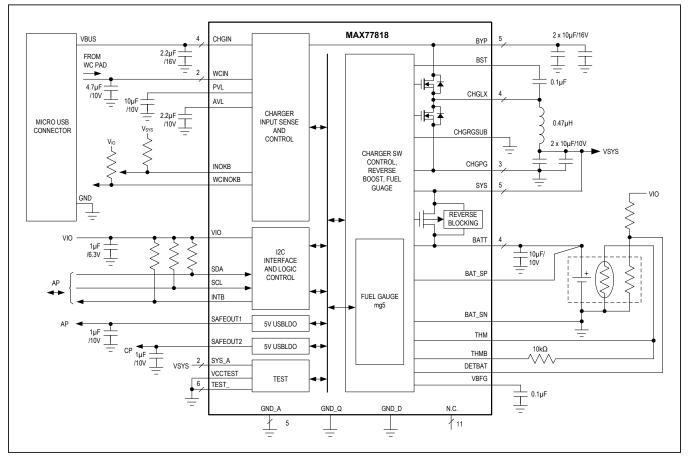
# Dual Input, Power Path, 3A Switching Mode Charger with FG

# **Pin Description (continued)**

DIN		FUNCTION
PIN	NAME	FUNCTION
C8, C9, D8, D9	CHGIN	Charger Input. The adapter/USB charger input may be active, or disabled using the CHGINSEL bit. Connect a $2.2\mu$ F/16V ceramic capacitor from CHGIN to GND plane.
D1–D5	GND_A	Analog Ground. Short to GND_D and GND_Q.
E3	GND_D	Digital Ground. Short to GND_A and GND_Q.
D6	AVL	Analog Voltage Level. Output of on-chip 5V LDO used to power on-chip, low-noise circuits. Bypass with a $2.2\mu$ F/10V ceramic capacitor to GND. Powering external loads from AVL is not recommended, other than pulldown resistors.
E1, F2	SYS_A	Analog SYS Input
E5, F5, G5, H5, H6	SYS	System Power Connection. Connect system loads to this node. Bypass with 2x10µF ceramic capacitors from SYS to CHGPG ground plane.
E7	PVL	Internal Bias Regulator High-Current Output Bypass. Supports internal noisy and high-current gate drive loads. Bypass to PGND with a minimum 10µF/10V ceramic capacitor.
F1	V <sub>BFG</sub>	1.8V power supply output for Fuel Gauge. Bypass V_{BFG} with a 0.1 $\mu$ F ceramic capacitor, V <sub>BFG</sub> is not intended to power external circuitry.
F6	BAT_SN	Battery Negative Differential Sense Connection. Connect to the negative or ground terminal close to the battery.
F7	BST	High-Side FET Driver Supply. Bypass BST to LX with a 0.1µF ceramic capacitor.
F8, F9, G8, G9	CHGLX	Charger Switching Node. Connect the inductor between CHGLX and SYS.
G1	ТНМВ	Pullup Voltage for THM Pin Pullup Resistor. Can be switched to save power.
G3, G4, H3, H4	BATT	Battery Power Connection. Connect to the positive terminal of a single-cell (or parallel cell) Li Ion battery. Bypass BATT to CHGPG ground plane with a $10\mu$ F ceramic capacitor.
G6	BAT_SP	Battery Positive Differential Sense Connection. Connect to the positive terminal close to the battery.
G7	CHGRGSUB	Substrate Charger Ground Connection. Connect with GND_A.
H2	ТНМ	Thermistor Connection. Determines battery temperature using ratiometric measurement.
H7–H9	CHGPG	Charger Power Ground Connection

# Dual Input, Power Path, 3A Switching Mode Charger with FG

## Block Diagram



## **Detailed Description**

### **System Faults**

MAX77818 monitors the system for the following faults:

V<sub>SYS</sub> undervoltage lockout

V<sub>SYS</sub> overvoltage lockout

### **V<sub>SYS</sub> Fault**

The system monitors the  $V_{SYS}$  node for undervoltage and overvoltage. The following describes the IC behavior if any of these events is to occur.

### V<sub>SYS</sub> Undervoltage Lockout (VSYSUVLO)

When charger input is valid and SYS node falls below SYS UVLO, all charger and fuel gauge O type registers are reset and following happen:

when DEADBAT < SYS < UVLO (= 2.5V), QBAT is on and SYS is shorted to BAT.

when 0 < SYS < DEADBAT (= 2.0V), QBAT is off, but the charger pulls up SYS from BAT with a constant current of 50mA.

when charger input is invalid and battery is present.

when DEADBAT < SYS < UVLO (= 2.5V), QBAT is on and SYS is shorted to BAT.

when 0 < SYS < DEADBAT (= 2.0V), QBAT is off.

### VSYS Overvoltage Lockout (VSYSUVLO)

The absolute maximum ratings state that the SYS node withstands up to 6V. The SYS OVLO threshold is set to 5.36V (typ). Ideally,  $V_{SYS}$  should not exceed the battery charge termination threshold. Systems must be designed so that  $V_{SYS}$  never exceeds 4.8V (transient and stead-state). If the  $V_{SYS}$  should exceed  $V_{SYSOVLO}$  during a fault, the MAX77818 resets the charger and fuel gauge O type registers.

# Dual Input, Power Path, 3A Switching Mode Charger with FG

### INTB

The MAX77818 uses one interrupt pin: INTB. The interrupt is meant to indicate to the application processor that the status of MAX77818 has changed. The INTB signal is asserted whenever one or more interrupts are toggled, and those interrupts are not masked. The application processor reads the interrupts in two steps. First, the AP reads the INTSRC register. This is a read-only register that indicates which functional block is generating the interrupt (i.e., charger and FG). Depending on the result of the read, the next step is to read the actual interrupt registers pertaining to the functional block.

For example, if the application processor reads 0x02 from INTSRC register, it means the top-level MAX77818 block has an interrupt generated. The next step is to read the related interrupt register of the MAX77818 functional block.

The INTB pin becomes high (cleared) as soon as the read sequence of the last INT\_ register that contains an active interrupt starts. FG interrupts are cleared by setting new threshold values. All interrupts can be masked to prevent the INTB from being asserted for masked interrupts. A mask bit in the INTM register implements masking. The INTSRC register can still provide the actual interrupt status of the masked interrupts, but the INTB pin is not asserted.

# Charger, Safeout LDO, and Charger Type Detection Interaction

The charger type detection circuit performs charger type detection and gates whether or not the charger is enabled. The charger type detection circuit allows the charger to be enabled once charge detection is complete, depending on the type of charger detected and whether or not it is USB 2.0 compliant. A manual override bit allows the user to enable the charger regardless of the charger type detection circuit charger detection status.

SAFEOUT1 is enabled by default once charger detection is complete and CHGIN is valid regardless of DETBATB. SAFEOUT2 can also be enabled once the same conditions are met, and the user sets the ENSAFEOUT2 register bit.

### Switching Mode Charger

### Features:

- Complete Li+/Li-poly battery charger
- Prequalification, constant current, constant voltage
- 55mA dead-battery prequalification
- 100mA low-battery prequalification current
- Adjustable constant current charge
  - OA to 3.0A in 50mA steps
  - ±5% accuracy
- Adjustable charge termination threshold
  - 100mA to 200mA in 25mA steps and 200mA to 350mA in 50mA steps
  - ±5% accuracy
- Adjustable battery regulation voltage
  - 3.625V to 4.700V in 25mV steps
  - ±0.5% accuracy at T = +25°C
  - ±1% accuracy
  - Remote differential sensing
- Synchronous switch-mode design
- Reverse boost mode with adjustable V<sub>BYP</sub> from 3.0V to 5.8V
- Smart Power Selector™
  - Optimally distributes power between charge adapter, system, and main battery
  - When powered by a charge adapter, the main battery can provide supplemental current to the system
  - The charge adapter and can support the system without a main battery
- No external MOSFETs required
- Dual input
  - Reverse leakage protection prevents the battery leaking current to the inputs
  - 4.0A adapter input
    - 16V withstand, 14V operating
    - Adjustable input current limit (100mA to 4.0A in 33.3mA steps (CHGIN\_ILIM), 500mA default)
    - Support AC-to-DC wall warts and USB adapters
  - 1.26A wireless charger input
    - 6V fault tolerant
    - Adjustable input current limit (60mA to 1.26A in 20mA steps (WCIN\_ILIM), 500mA default)

Smart Power Selector is a trademark of Maxim Integrated Products, Inc.

# Dual Input, Power Path, 3A Switching Mode Charger with FG

- Charge safety timer
  - Selectable: 4hr to 16hr in 2hr steps plus a disable setting
- Die temperature monitor with thermal foldback loop
  - Selectable die temperature thresholds (°C): 70, 85,100, and 115
- Input voltage dropout control allows operation from high-impedance sources. Charge current is reduced so input is not pulled below 4.3V.
- BATT to SYS switch is 12.8mΩ (typ).
- Dead battery detection

- Short-circuit protection
  - Programmable BAT to SYS overcurrent threshold from 3.0A to 4.5A in 0.25A steps plus a disable setting
  - DISIBS bit allows the host to disable the battery to system discharge path to protect against a shortcircuit
  - · SYS short to ground
    - BUCK current is limited by by the ILIM current limit. BATT currents above the programmed by B2SOVRC threshold generate an interrupt. The host can then disable the battery to system discharge path by setting DISIBS.

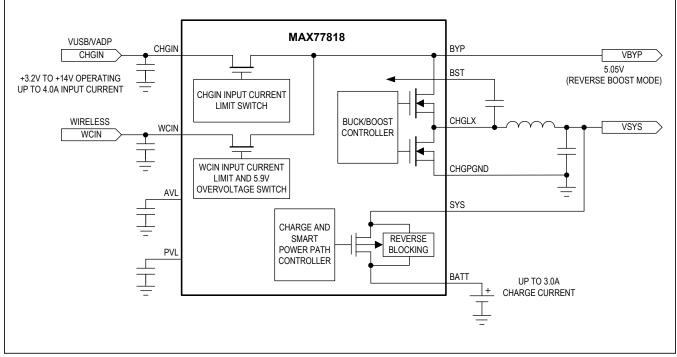


Figure 1. Simplified Functional Diagram

# Dual Input, Power Path, 3A Switching Mode Charger with FG

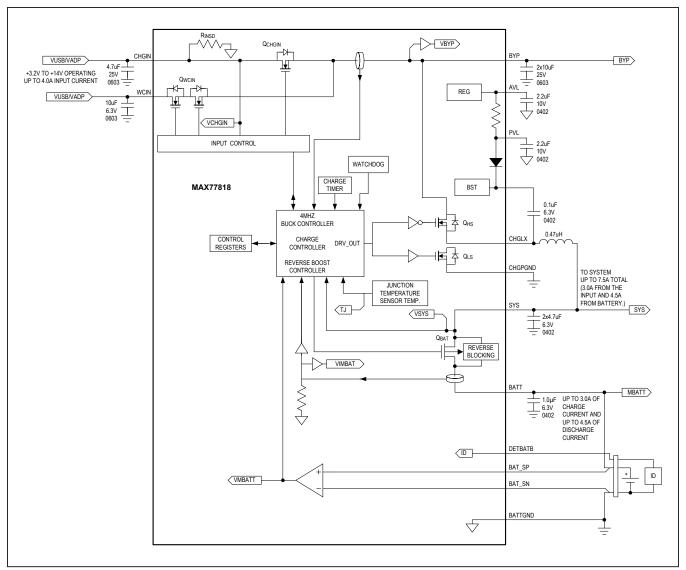


Figure 2. Main Battery Charger Detailed Functional Diagram

# Dual Input, Power Path, 3A Switching Mode Charger with FG

### **Detailed Description**

The MAX77818 includes a full-featured switch-mode charger for a one-cell lithium ion (Li+) or lithium polymer (Li-poly) battery. As shown in Figure 2, the current limit for CHGIN input is independently programmable from 0 to 3.0A in 33.3mA steps allowing the flexibility for connection to either an AC-to-DC wall charger or a USB port. CHGIN current limit default is set between 100mA and 500mA with 500mA being the programmed default.

The synchronous switch-mode DC-DC converter utilizes a high 4.0MHz switching frequency which is ideal for portable devices because it allows the use of small components while eliminating excessive heat generation. The DC-DC has both a buck and a boost mode of operation. When charging the main battery the converter operation as a buck. The DC-DC buck operates from a 3.2V to 14V source and delivers up to 3.0A to the battery. Battery charge current is programmable from 0A to 3.0A. As a boost converter, the DC-DC uses energy from the main battery to boost the voltage at BYP. The boosted BYP voltage is useful to provide the supply the USB OTG voltage.

Maxim's Smart Power Selector architecture makes the best use of the limited adapter power and the battery's power at all times to supply up to 3.0A continuous (4A peak) from the buck to the system. Additionally, supplement mode provides additional current from the battery to the system up to  $4.5A_{RMS}$ . Adapter power that is not used for the system goes to charging the battery. All power switches for charging and switching the system load between battery and adapter power are included on chip. No external MOSFETs are required.

Maxim's proprietary process technology allows for low-R<sub>DSON</sub> devices in a small solution size. The total dropout resistance from adapter power input to the battery is 0.0999 $\Omega$  (typ) assuming that the inductor has 0.04 $\Omega$  of ESR. This 0.0999 $\Omega$  typical dropout resistance allows for charging a battery up to 3.0A from a 5V supply. The resistance from the BATT to SYS node is 0.0128 $\Omega$ , allowing for low power dissipation and long battery life.

A multitude of safety features ensures reliable charging. Features include a charge timer, watchdog, junction thermal regulation, over/undervoltage protection, and shortcircuit protection.

The BATT to SYS switch has overcurrent protection. See the <u>Main battery Overcurrent Protection</u> section for more information.

### **Smart Power Selector**

The Smart Power Selector architecture is a network of internal switches and control loops that distributes energy between an external power source CHGIN, BYP, SYS, and BATT.

<u>Figure 1</u> shows a simplified arrangement for the smart power selector's power steering switches. <u>Figure 2</u> shows a more detailed arrangement of the smart power selector switches and gives them the following names:  $Q_{CHGIN}$ ,  $Q_{HS}$ ,  $Q_{LS}$ , and  $Q_{BAT}$ .

### Switch and Control Loop Descriptions

**Input Switch:**  $Q_{CHGIN}$  provides the input current limit. The input switch is completely on and does not provide forward blocking. As shown in <u>Figure 2</u>, there are SPS control loops that monitor the current through the input switches as well as the input voltage.

**DC-DC Switches:**  $Q_{HS}$  and  $Q_{LS}$  are the DC-DC switches that can operate as a buck (step-down) or a boost (step-up). When operating as a buck, energy is moved from BYP to SYS. When operating as a boost, energy is moved from SYS to BYP. SPS control loops monitor the DC-DC switch current, the SYS voltage, and the BYP voltage.

**Battery-to-System Switch:**  $Q_{BAT}$  controls the battery charging and discharging. Additionally  $Q_{BAT}$  allows the battery to be isolated from the system (SYS). An SPS control loop monitors the  $Q_{BAT}$  current.

### **Control Bits**

MODE configures the Smart Power Selector.

MINVSYS sets the minimum system voltage.

VBYPSET sets the BYP regulation voltage target.

B2SOVRC configures the main battery overcurrent protection.

### **Energy Distribution Priority:**

With a valid external power source:

The external power source is the primary source of energy.

The main battery is the secondary source of energy.

Energy delivery to BYP is the highest priority.

Energy delivery to SYS is the second priority.

Any energy that is not required by BYP or SYS is available to the main battery charger.

With no power source available at CHGIN:

The main battery is the primary source of energy.

Energy delivery to BYP is the highest priority.

BYP includes the CHGIN if they are asked to supply energy in a USB OTG type of application.

Energy delivery to SYS is the second priority.

### **BYP Regulation Voltage**

When the DC-DC is enabled in boost only mode (MODE = 0x08), the voltage from BYP to ground (V<sub>BYP</sub>) is regulated to VBYPSET.

When the DC-DC is enabled in one of its USB OTG modes (MODE = 0x09 or MODE = 0x0A), V<sub>BYP</sub> is set for 5.1V (V<sub>BYP.ORG</sub>).

When the DC-DC is off or in one of its buck modes (MODE = 0x00 or MODE = 0x04 or MODE = 0x05) and there is a valid power source at CHGIN,  $V_{BYP} = V_{CHGIN} - I_{CHGIN} \times R_{QCHGIN}$  When the DC-DC is off and there is no valid power source at CHGIN, BYP is connected to SYS with an internal 200 $\Omega$  resistor. This 200 $\Omega$  resistor keeps BYP biased as SYS and allows for the system to draw very light loads from BYP. IF the system loading on BYP is more than 1.0mA then the DC-DC should be operated in boost mode. Note that the inductor and the high-side switch's body diode are in parallel with the 200 $\Omega$  from SYS to BYP.

### SYS Regulation Voltage

When the DC-DC is enabled as a buck and the charger is disabled (MODE = 0x04),  $V_{SYS}$  is regulated to  $V_{BATREG}$  (CHG\_CV\_PRM) and  $Q_{BAT}$  is off.

When the DC-DC is enabled as a buck and the charger enabled but in a non-charging state such as done, watch-dog suspend or timer fault (MODE = 0x05 and not charging),  $V_{SYS}$  is regulated to  $V_{BATREG}$  (CHG\_CV\_PRM) and  $Q_{BAT}$  is off.

When the DC-DC is enabled as a buck and charging in prequalification, fast-charge, or top-off modes (MODE = 0x05 and charging),  $V_{SYS}$  is regulated to  $V_{SYSMIN}$  when the  $V_{BATT} < V_{SYSMIN}$ ; in this mode the  $Q_{BAT}$  switch acts like a linear regulator and dissipates power [P = ( $V_{SYSMIN} - V_{BATT}$ ) x I<sub>BATT</sub>]. When  $V_{BATT} > V_{SYSMIN}$ , then  $V_{SYS} = V_{BATT} - I_{BATT} \times R_{BAT2SYS}$ ; in this mode the  $Q_{BAT}$  switch is closed.

In all of the above modes, if the combined SYS and BYP loading exceed the input current limit, then V<sub>SYS</sub> drops to V<sub>BATT</sub> - V<sub>BSREG</sub> and the battery provides supplemental current. If the fuel gauge requests main battery information (voltage and current) during this supplement mode, then the Q<sub>BAT</sub> switch is closed (V<sub>SYS</sub> = V<sub>BATT</sub> - I<sub>BATT</sub> x R<sub>BAT2SYS</sub>) during the fuel gauge sample. If the fuel

# Dual Input, Power Path, 3A Switching Mode Charger with FG

gauge wants requests continuous samples from the main battery during supplement mode, then the  $Q_{BAT}$  switch eventually opens when  $I_{BATT}$  decreases below 40mA.

When the DC-DC is enabled as a boost (MODE = 0x08 or 0x09 or 0x0A), then the QBAT switch is closed and  $V_{SYS}$  =  $V_{BATT} - I_{BATT} \times R_{BAT2SYS}$ 

### Battery Detect Input Pin (DETBATB)

DETBATB is tied to the ID pin of the battery pack. If DETBATB is pulled below 80% of V<sub>IO</sub> pin voltage, this is an indication that the main battery is present and the battery charger starts upon valid CHGIN. If DETBATB is left unconnected or equal to V<sub>IO</sub> voltage, this indicates that the battery is not present and the charger does not start upon valid CHGIN, see Figure 3. The DETBATB is internally pulled to BATT through an external resistor.

DETBATB status bit is valid when BATT is not present.

### **Input Validation**

As shown in <u>Figure 4</u>, the charger input is compared with several voltage thresholds to determine if it is valid. A charger input must meet the following three characteristics to be valid:

CHGIN must be above V<sub>CHGIN UVLO</sub> to be valid.

CHGIN must be below its overvoltage lockout threshold  $(V_{OVLO})$ .

CHGIN must be above the system voltage by V<sub>CHGIN2SYS</sub>.

CHGIN input generates a CHGIN\_I interrupt when its status changes. The input status can be read with CHGIN\_OK and CHGIN\_DTLS. Interrupts can be masked with CHGIN\_M.

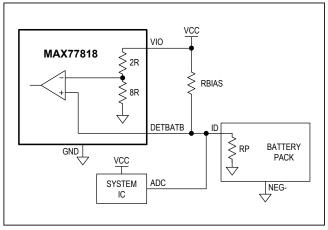


Figure 3. DETBATB Internal Circuitry and System Diagram

# Dual Input, Power Path, 3A Switching Mode Charger with FG

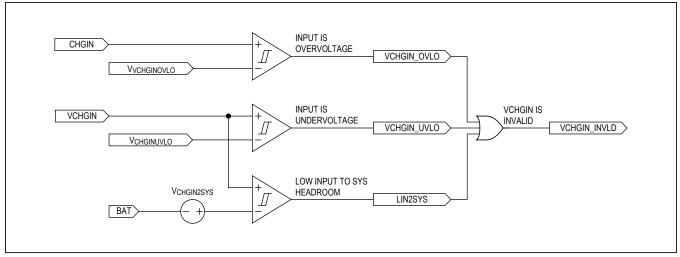


Figure 4. Charger Input Validation

### Input Current Limit

The default settings of the CHGIN\_ILIM and MODE control bits are such that when a charge source is applied to CHGIN, the MAX77818 turns its DC-DC converter on in BUCK mode, limit  $V_{SYS}$  to  $V_{BATREG}$ , and limit the charge source current to 500mA. All control bits are reset on global shutdown.

### Input Voltage Regulation Loop

An input voltage regulation loop allows the charger to be well behaved when it is attached to a poor quality power source (CHGIN pin) or wireless charger (WCIN pin). The loop improves performance with relatively high-resistance charge sources that exist when long cables are used or devices are charged with noncompliant USB hub configurations. Additionally, this input voltage regulation loop improves performance with current limited adapters. If the MAX77818's input current limit is programmed above the current limit threshold of given adapter, the input voltage loop allows the MAX77818 to regulate at the current limit of the adapter. Finally, the input voltage regulation loop allows the MAX77818 to perform well with adapters that have poor transient load response times.

The input voltage regulation loop automatically reducing the input current limit in order to keep the input voltage at V<sub>CHGIN\_REG</sub>, V<sub>WCIN\_REG</sub>. If the input current limit is reduced to I<sub>CHGIN\_REG\_OFF</sub> (50mA typ) and the input voltage is below V<sub>CHGIN\_REG</sub>, then the charger input is turned off. V<sub>CHGIN\_REG</sub>, V<sub>WCIN\_REG</sub> is programmable with V<sub>CHGIN\_REG</sub> and V<sub>WCIN\_REG</sub>.

After operating with the input voltage regulation active, a BYP\_I interrupt is generated, BYP\_OK is cleared and

BYP\_DTLS = 0b1xxx. To optimize input power when working with a current limited charge source, monitor the BYP\_DTLS while decreasing the input current limit. When the input current limit is set below the limit of the adapter, the input voltage rises. Although the input current limit is lowered, more power can be extracted from the input source when the input voltage is allowed to rise.

Example 1: Optimum use of the input voltage regulation loop along with a current limited adapter.

### Sequence of Events

 $V_{BATT}$  = 3.2V, the system is operating normally

A 5.0V 1.2A current limited dedicated USB charger is applied to CHGIN.

The DC-DC buck regulator turns on,  $V_{SYS}$  is regulated to  $V_{BATREG}$  (4.2V) and the input is allowed to provide 100mA to the system.

The system detects that the charge source is a dedicated USB charger and enables the battery charger (MODE = 0x05) and programs an input current limit to 1.8A (CHGIN\_ILIM = 0x36 = 1.8A).

The input current limit starts to ramp up from 100mA to 1.8A, but at the input current limit of the adapter (1.2A), the adapter voltage collapses. The MAX77818's input-voltage regulation loop prevents the adapter voltage from falling below 4.3V (V<sub>CHGIN\_REG</sub> = 4.3V). A BYP\_I interrupt is generated and BYP\_DTLS3 is set.

With the input voltage regulation loop active, the adapter provides 1.2A at 4.3V, which is a total of 5.04W being delivered to the system.

# Dual Input, Power Path, 3A Switching Mode Charger with FG

The system software detects that the input voltage regulation loop is active and it begins to ramp down the programmed input current limit. When the current limit ramps down to 1.167A (CHGIN\_ILIM), the adapter is no longer in current limit and the adapter voltage increases from 4.3V to 5.0V.

With the adapter operating just below its current limit, it provides 1.167A at 5.0V which is a total of 5.84W to the system. This is 800mW more than when the adapter was in current limit.

### Input Self-Discharge for Reliable Charger Input Interrupt

To ensure that a rapid removal and reinsertion of a charge source always results in a charger input interrupt, the charger input presents loading to the input capacitor to ensure that when the charge source is removed the input voltage decays below the UVLO threshold in a reasonable time. A 10µF input capacitance charged up to the maximum OVLO threshold (6.0V -  $V_{OVLO}$ ) decays down to the minimum UVLO threshold (4.3V -  $V_{CHGINx\_UVLO\_MIN}$ ) within 300ms (t<sub>INSD</sub>). The input self-discharge is implemented by with a 30k $\Omega$  resistor (R<sub>INSD</sub>) from CHGIN input to ground.

### System Self-Discharge with No Power

To ensure a timely, complete, repeatable, and reliable reset behavior when the system has no power, the MAX77818 actively discharges the BATT and SYS nodes when the main battery is removed and V<sub>SYS</sub> is less than V<sub>SYSUVLO</sub>. As shown in Figure 5, the BATT and SYS discharge resistors are both  $600\Omega$ .

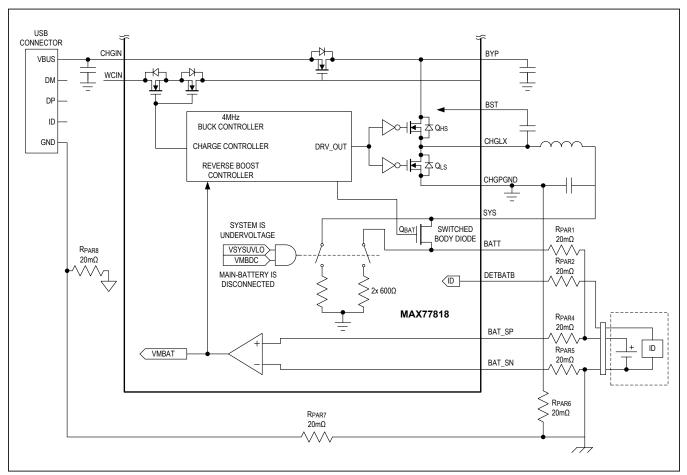


Figure 5. Main Battery Charger High-Current Paths with Typical Parasitic Resistances and Self-Discharging Resistors

# Dual Input, Power Path, 3A Switching Mode Charger with FG

### **Charge States**

The MAX77818 utilizes several charging states to safely and quickly charge batteries as shown in <u>Figure 6</u> and <u>Figure 7</u>. <u>Figure 6</u> shows an exaggerated view of a Li+/Li-Poly battery progressing through the following charge states when there is not system load and the die and battery are close to room temperature: prequalification  $\rightarrow$  fast-charge  $\rightarrow$  top-off  $\rightarrow$  done.

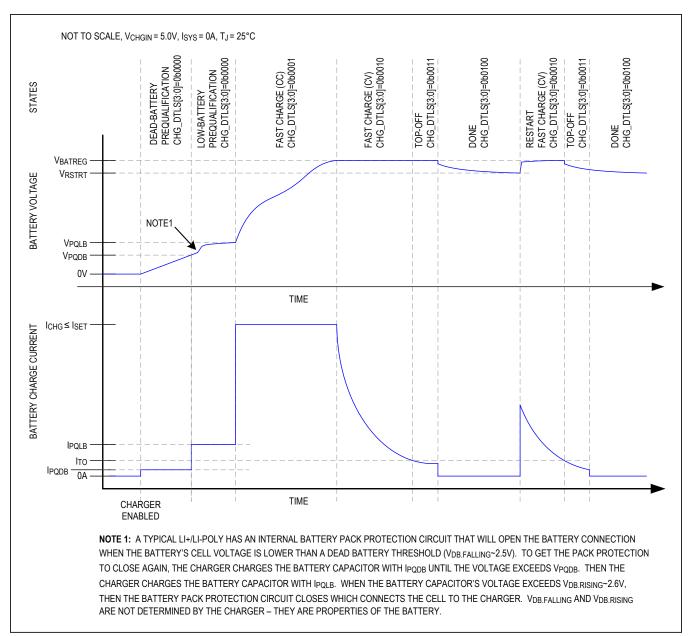


Figure 6. Li+/Li-Poly Charge Profile

# Dual Input, Power Path, 3A Switching Mode Charger with FG

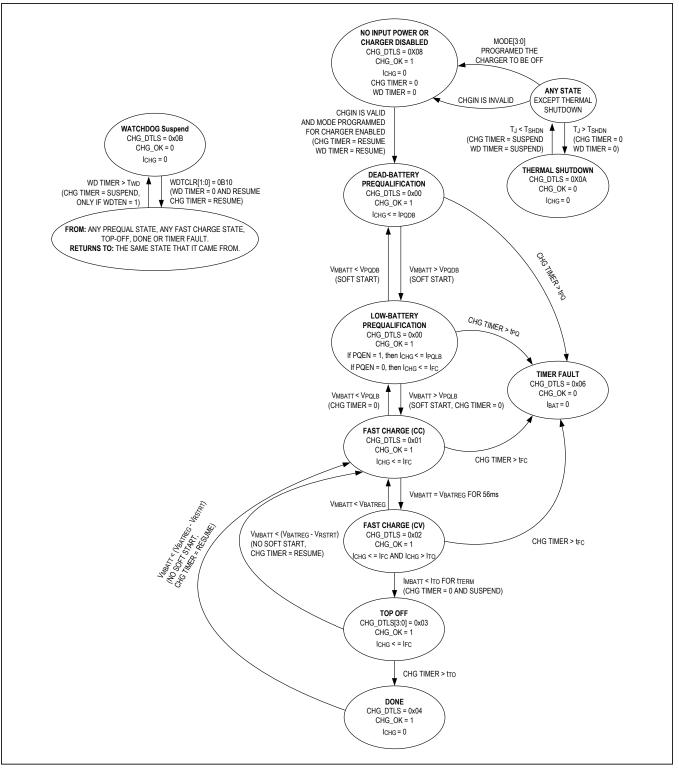


Figure 7. Charger State Diagram

# Dual Input, Power Path, 3A Switching Mode Charger with FG

### No Input Power or Charger Disabled State

From any state shown in Figure 7 except thermal shutdown, the no input power or charger disabled state is entered whenever the charger is programmed to be off or the charger input CHGIN is invalid. After being in this state for t<sub>SCIDG</sub>, a CHG\_I interrupt is generated, CHG\_OK is set and CHG\_DTLS is set to 0x08

While in the no input power or charger disabled state, the charger current is 0mA, the watchdog and charge timers are forced to 0, and the power to the system is provided by either the battery or the adapter. When both battery and adapter power is available, the adapter provides primary power to the system and the battery contributes supplemental energy to the system if necessary.

To exit the no input power or charger disabled state, the charger input must be valid and the charger must be enabled.

### **Dead Battery Prequalificiation State**

As shown in Figure 7, the dead battery prequalification state occurs when the main battery voltage is less than V<sub>PQDB</sub>. After being in this state for t<sub>SCIDG</sub>, a CHG\_I interrupt is generated, CHG\_OK is set and CHG\_DTLS is set to 0x00. In the dead battery prequalification state charge current into the battery is I<sub>PQDB</sub>.

Following events causes the state machine to exit this state:

The main battery voltage rises above  $V_{PQDB}$  and the charger enters the next state in the charging cycle: low battery prequalification.

If the battery charger remains in this state for longer than  $t_{PQ}$ , the charger state machine transitions to the timer fault state.

If the watchdog timer is not serviced, the charger state machine transitions to the watchdog suspend state.

Note that the dead battery prequalification state works with battery voltages down to 0V. The low 0V operation typically allows this battery charger to recover batteries that have an open internal pack protector. Typically a packs internal protection circuit opens if the battery has seen an over current, undervoltage, or overvoltage. When a battery with an open internal pack protector is used with this charger, the low battery prequalification mode current flows into the 0V battery. This current raises the pack's terminal voltage to the pointer where the internal pack protection switch closes.

Note that a normal battery typically stays in the low battery prequalification state for several minutes or less. Therefore, a battery that stays in low battery prequalification for longer than  $t_{PQ}$  may be experiencing a problem.

### Fast-Charge Constant Current State

As shown in <u>Figure 7</u>, the fast-charge constant current (CC) state occurs when the main battery voltage is greater than the low battery prequalification threshold and less than the battery regulation threshold ( $V_{PQLB} < V_{BATT} < V_{BATREG}$ ). After being in the fast-charge CC state for t<sub>SCIDG</sub>, a CHG\_I interrupt is generated, CHG\_OK is set and CHG\_DTLS = 0x01.

In the fast-charge CC state, the current into the battery is less than or equal to  $I_{FC}$ . Charge current can be less than  $I_{FC}$  for any of the following reasons:

The charger input is in input current limit.

The charger input voltage is low.

The charger is in thermal foldback.

The system load is consuming adapter current. Note that the system load always gets priority over the battery charge current.

Following events causes the state machine to exit this state:

When the main battery voltage rises above  $V_{BATREG}$ , the charger enters the next state in the charging cycle: fast charge (CV).

If the battery charger remains in this state for longer than  $t_{FC}$ , the charger state machine transitions to the timer fault state.

If the watchdog timer is not serviced, the charger state machine transitions to the watchdog suspend state.

The battery charger dissipates the most power in the fast-charge constant current state. This power dissipation causes the internal die temperature to rise. If the die temperature exceeds  $T_{REG}$ ,  $I_{FC}$  is reduced.

### Fast-Charge Constant Voltage State

As shown in <u>Figure 7</u>, the fast-charge constant voltage (CV) state occurs when the battery voltage rises to  $V_{BATREG}$  from the fast-charge CC state. After being in the fast-charge CV state for t<sub>SCIDG</sub>, a CHG\_I interrupt is generated, CHG\_OK is set and CHG\_DTLS = 0x02.

In the fast-charge CV state the battery charger maintains  $V_{BATREG}$  across the battery and the charge current is less than or equal to I<sub>FC</sub>. As shown in <u>Figure 6</u>, charger current decreases exponentially in this state as the battery becomes fully charged.

The smart power selector control circuitry may reduce the charge current lower than the battery may otherwise consume for any of the following reasons:

The charger input is in input current limit.

The charger input voltage is low.

The charger is in thermal foldback.

The system load is consuming adapter current. Note that the system load always gets priority over the battery charge current.

Following events causes the state machine to exit this state:

When the charger current is below  $I_{TO}$  for  $t_{term}$ , the charger enters the next state in the charging cycle: TOP OFF.

If the battery charger remains in this state for longer than  $t_{FC}$ , the charger state machine transitions to the timer fault state.

If the watchdog timer is not serviced, the charger state machine transitions to the watchdog suspend state.

### **Top-Off State**

As shown in <u>Figure 7</u>, the top-off state can only be entered from the fast-charge CV state when the charger current decreases below I<sub>TO</sub> for t<sub>TERM</sub>. After being in the top-off state for t<sub>SCIDG</sub>, a CHG\_I interrupt is generated, CHG\_OK is set and CHG\_DTLS = 0x03. In the top-off state the battery charger tries to maintain V<sub>BATREG</sub> across the battery and typically the charge current is less than or equal to I<sub>TO</sub>.

The smart power selector control circuitry can reduce the charge current lower than the battery is able to. Otherwise, consume for any of the following reasons:

The charger input is in input current limit.

The charger input voltage is low.

The charger is in thermal foldback.

The system load is consuming adapter current. Note that the system load always gets priority over the battery charge current.

Following events causes the state machine to exit this state:

After being in this state for the top-off time  $(t_{TO})$ , the charger enters the next state in the charging cycle: DONE.

If  $V_{BATT} < V_{BATREG} - V_{RSTRT}$ , the charger goes back to the FAST CHARGE (CC) state.

If the watchdog timer is not serviced, the charger state machine transitions to the watchdog suspend state.

# Dual Input, Power Path, 3A Switching Mode Charger with FG

### **Done State**

As shown in Figure 7, the battery charger enters its done state after the charger has been in the top-off state for  $t_{TO}$ . After being in this state for  $t_{SCIDG}$ , a CHG\_I interrupt is generated, CHG\_OK is cleared and CHG\_DTLS = 0x04.

Following events causes the state machine to exit this state:

If  $V_{BATT} < V_{BATREG} - V_{RSTRT}$ , the charger goes back to the fast charge (CC) state.

If the watchdog timer is not serviced, the charger state machine transitions to the watchdog suspend state.

In the done state, the charge current into the battery ( $I_{CHG}$ ) is 0A. In the done state, the charger presents a very low load ( $I_{MBDN}$ ) to the battery. If the system load presented to the battery is low (<< 100µA), then a typical system can remain in the done state for many days. If left in the done state long enough, the battery voltage decays below the restart threshold ( $V_{RSTRT}$ ) and the charger state machine transitions back into the fast-charge CV state. There is no soft-start (di/dt limiting) during the done to fast-charge state transition.

### **Timer Fault State**

The battery charger provides both a charge timer and a watchdog timer to ensure safe charging. As shown in Figure 7, the charge timer prevents the battery from charging indefinitely. The time that the charger is allowed to remain in its each of its prequalification states is  $t_{PQ}$ . The time that the charger is allowed to remain in the charger is allowed to remain in the fast-charge CC and CV states is  $t_{FC}$  which is programmable with FCHGTIME. Finally, the time that the charger is in the top-off state is  $t_{TO}$ , which is programmable with TO\_TIME. Upon entering the timer fault state a CHG\_I interrupt is generated without a delay, CHG\_OK is cleared and CHG\_DTLS = 0x06.

In the timer fault state the charger is off. The charger can exit the timer fault state by programming the charger to be off and then programming it to be on again through the MODE bits. Alternatively, the charger input can be removed and reinserted to exit the timer fault state. See the any state bubble in the upper right of Figure 7.

### Watchdog Timer

The battery charger provides both a charge timer and a watchdog timer to ensure safe charging. As shown in Figure 7, the watchdog timer protects the battery from charging indefinitely in the event that the host hangs or otherwise cannot communicate correctly. The watchdog timer is disabled by default with WDTEN = 0. To use

# Dual Input, Power Path, 3A Switching Mode Charger with FG

the watchdog timer feature enable the feature by setting WDTEN. While enabled, the system controller must reset the watchdog timer within the timer period ( $t_{WD}$ ) for the charger to operate normally. Reset the watchdog timer by programming WDTCLR = 0x01.

If the watchdog timer expires while the charger is in dead battery prequalification, low battery prequalification, fast charge CC or CV, top-off, done, or timer fault, the charging stops, a CHG\_I interrupt is generated without a delay, CHG\_OK is cleared, and CHG\_DTLS indicates that the charger is off because the watchdog timer expired. Once the watchdog timer has expired, the charger can be restarted by programming WDTCLR = 0x01. The SYS node can be supported by the battery and/or the adapter through the DC-DC buck while the watchdog timer is expired.

### **Thermal Shutdown State**

As shown in <u>Figure 7</u>, the thermal shutdown state occurs when the battery charger is in any state and the junction temperature (T<sub>J</sub>) exceeds the device's thermal shutdown threshold (T<sub>SHDN</sub>). When T<sub>J</sub> is close to T<sub>SHDN</sub>, the charger has folded back the input current limit to 0A so the charger and inputs are effectively off. Upon entering this state, CHG\_I interrupt is generated without a delay, CHG\_OK is cleared, and CHG\_DTLS = 0x0A.

In the thermal shutdown state the charger is off and timers are suspended. The charger exits the temperature suspend state and returns to the state it came from once the die temperature has cooled. The timers resume once the charger exits this state.

### Main Battery Differential Voltage Sense

As shown in <u>Figure 2</u>, BAT\_SP and BAT\_SN are differential remote sense lines for the main battery. To improve accuracy and decrease charging times, the battery charger voltage sense is based on the differential voltage between BAT\_SP and BAT\_SN.

<u>Figure 5</u> shows the high-current paths of the battery charger along with some example parasitic resistances. A Maxim battery charger without the remote-sensing function would typically measure the battery voltage between BATT and GND. In the case <u>Figure 5</u> with a charge current of 1A measuring from BATT to GND leads to a V<sub>BATT</sub> that is 40mV higher than the real voltage because of R<sub>PAR1</sub> and R<sub>PAR7</sub> (I<sub>CHG</sub> x (R<sub>PAR1</sub> + R<sub>PQR7</sub>) = 1A x 40m $\Omega$  = 40mV). Since the charger thinks the battery voltage is higher than it actually is, it will enter its fast-charge CV state sooner and the effective charge time may be extended by 10 minutes (based on real lab measurements). This charger with differential remote sensing does

not experience this type of problem because BAT\_SP and BAT\_SN sense the battery voltage directly. To get the maximum benefit from these sense lines connect them as close as possible to the main battery connector.

### **OTG Mode**

The DC-DC converter topology of the MAX77818 allows it to operate as a forward buck converter or as a reverse boost converter. The modes of the DC-DC converter are controlled with MODE. When MODE = 0x09 or 0x0A the DC-DC converter operates in reverse boost mode allowing it to source current to CHGIN. These two modes allow current to be sourced from CHGIN are commonly referred to as OTG modes (the term OTG is based off of the Universal Serial Bus's On the Go concept).

When MODE = 0x09 or 0x0A the DC-DC converter operates in reverse boost mode and regulates  $V_{BYP}$  to  $V_{BYP.OTG}$  (5.1V typ) and the switch from BYP to CHGIN is closed. The current through the BYP to CHGIN switch is limited to the value programmed by OTG\_ILIM. The two OTG\_ILIM options allow for supplying 100mA or 500mA to an external load.. When the OTG mode is selected, the unipolar CHGIN transfer function measures current going out of CHGIN. When OTG mode is not selected, the unipolar CHGIN transfer function measures current going into CHGIN.

If the external OTG load at CHGIN exceeds I<sub>CHGIN.OTG.</sub> I<sub>LIM</sub>, then a BYP\_I interrupt is generated, BYP\_OK = 0, and BYP\_DTLS = 0bxxx1. In response to an overload at CHGIN during OTG mode operation, the BYP to CHGIN switch is latched off. The BYP to CHGIN switch will automatically try to retry in ~300ms. If the overload at CHGIN persists, then the switch will toggle on and off with ~30ms on and ~300ms off.

# Main Battery Overcurrent Protection During System Power-Up

The main battery overcurrent protection during system power-up feature limits the main battery to system current to  $I_{SYSPU}$  as long as  $V_{SYS}$  is less than  $V_{SYSPU}$ . This feature limits the surge current that typically flows from the main battery to the device's low-impedance system bypass capacitors during a system power-up. System power-up is anytime that energy from the battery is supplied to SYS when  $V_{SYS} < V_{SYSPU}$ . This system power-up condition typically occurs when a battery is hot-inserted into an otherwise unpowered device. Similarly, the system power-up condition could occur when the DISIBS bit is driven low.

When system power-up occurs due to hot insertion into an otherwise unpowered device, a small delay of ( $t_{SYS-PU}$ ) is required in order for this feature's control circuits to activate. A current spike over  $I_{SYSPU}$  can occur during this time.

### Main Battery Overcurrent Protection Due to Fault

The MAX77818 protects itself, the battery, and the system from potential damage due to excessive battery discharge current. Excessive battery discharge current may occur in a smartphone for several reasons such as exposure to moisture, a software problem, an IC failure, a component failure, or a mechanical failure that causes a short circuit. The main battery overcurrent protection feature is enabled with B2SOVRC; disabling this feature reduces the main battery current consumption by I<sub>MBOVRC</sub>.

When the main battery (BATT) to system (SYS) discharge current ( $I_{BATT}$ ) exceeds the programmed overcurrent threshold for at least  $t_{MBOVRC}$ , a BAT\_I interrupt is generated, BAT\_OK is cleared, and BAT\_DTLS reports and overcurrent condition. Typically when the system's processor detects this overcurrent interrupt it executes a housekeeping routine that tries to mitigate the overcurrent situation. If the processor cannot correct the overcurrent, then it can disable the BATT to SYS discharge path (B2S switch) by driving DISIBS bit to a logic high.

There are different scenarios of how the MAX77818 responds to setting the DISIBS bit high depending on the available power source and the state of the charger.

The MAX77818 is only powered from BATT and DISIBS bit is set.

SYS collapses and is allowed to go to 0V.

DISIBS holds state.

To exit from this state, plug in a valid input charger, then SYS is powered up, and the system wakes up.

The MAX77818 is powered from BATT and CHGIN, and the charger buck is not switching and DISIBS bit is set.

# Dual Input, Power Path, 3A Switching Mode Charger with FG

To exit from this state, plug in a valid input charger, then SYS is powered up and the system wakes up.

The MAX77818 is powered from BATT and CHGIN and the charger buck is switching and DISIBS bit is set.

The DISIBIS bit is ignored.

### **Thermal Management**

The MAX77818 charger uses several thermal management techniques to prevent excessive battery and die temperatures.

### **Thermal Monitor**

The user can monitor thermistor temperature using the fuel gauge and adjust the charger voltage/current as needed.

### Thermal Foldback

Thermal foldback maximizes the battery charge current while regulating the MAX77818 junction temperature. As shown in Figure 8, when the die temperature exceeds the value programmed by REGTEMP (T<sub>JREG</sub>), a thermal limiting circuit reduces the battery charger's target current by 105mA/°C (ATJREG). The target charge current reduction is achieved with an analog control loop (i.e., not a digital reduction in the input current). When the thermal foldback loop changes state a CHG I interrupt is generated and the system's microprocessor may want to read the status of the thermal regulation loop through the TREG status bit. Note that the thermal foldback loop being active is not considered to be abnormal operation and the thermal foldback loop status does not affect the CHG OK bit (only information contained within CHG DTLS affects CHG OK).

### Analog Low-Noise Power Input (AVL) and PVL

As shown in Figure 2, AVL is a regulated output from BYPC node. AVL is the power input for the MAX77818 charger's analog circuitry. PVL has a  $12.5\Omega$  resistor internal to the MAX77818 and a  $10\mu$ F ceramic capacitor external bypass capacitor to isolate noises from AVL.

# Dual Input, Power Path, 3A Switching Mode Charger with FG

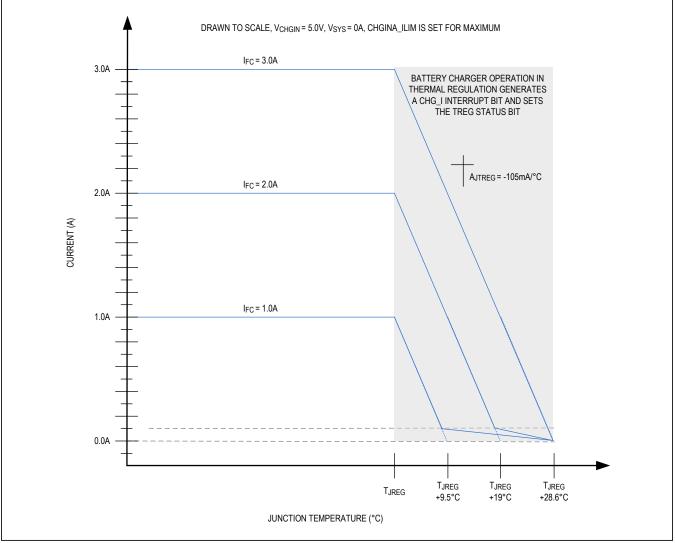


Figure 8. Charge Currents vs. Junction Temperature

# Dual Input, Power Path, 3A Switching Mode Charger with FG

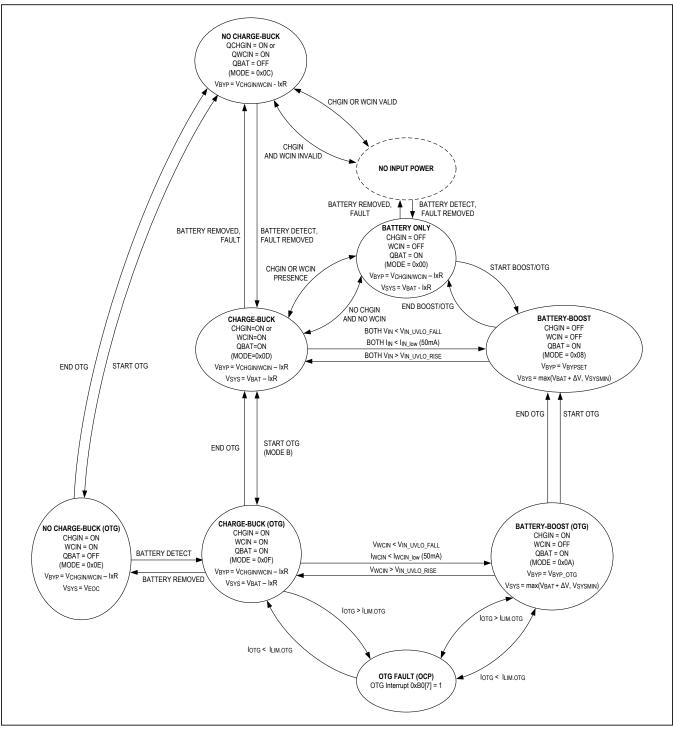


Figure 9: Power State Diagram

# Dual Input, Power Path, 3A Switching Mode Charger with FG

### **Power States**

The MAX77818 transitions between power states as input/battery and load conditions dictate; see Figure 9.

The MAX77818 provides seven (7) power states and one (1) no power state (see the **TBD** section, register description CHG\_CNFG\_00 [3:0]). Under power-limited conditions, the power path feature maintains SYS and USB-OTG loads at the expense of battery charge current. In addition, the battery supplements the input power when required. As shown, transitions between power states are initiated by detection/removal of valid power sources, OTG events, and under-voltage conditions. Details of the BYP and SYS voltages are provided for each state. **No Input Power, <u>MODE = undefined</u>:** No input adapter or battery is detected. The charger and system is off. Battery is disconnected and charger is off.

**Battery Only, <u>MODE = 0x00</u>**: Adapter and wireless charger are invalid, outside the input voltage operating range (QCHGIN = off, QWCIN = off). Battery is connected to power the SYS load (QBAT = on), and boost is ready to power OTG (Boost=standby), see Figure 10. **Battery Only**.

**Battery Boost, MODE = 0x08:** Adapter and Wireless inputs are invalid, outside the input voltage operating range (QCHGIN = off, QWCIN = off). Battery is connected to power the SYS load (QBAT = on), and charger is operating in Boost mode (Boost = on). See Figure 11.

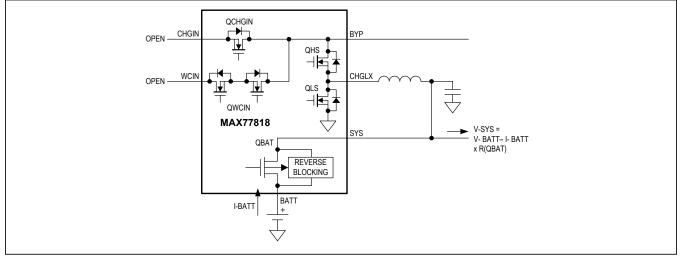


Figure 10. Battery-Only

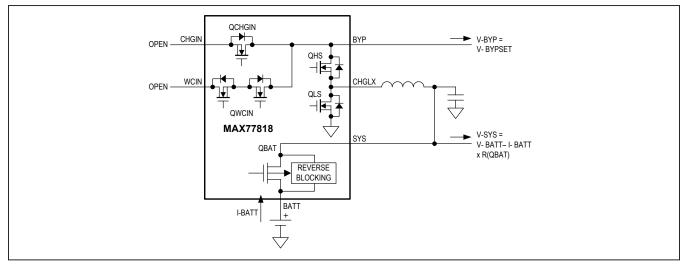


Figure 11. Battery-Boost

# Dual Input, Power Path, 3A Switching Mode Charger with FG

#### **Battery Boost**

**Battery Boost (OTG), <u>MODE = 0x0A</u>:** Wireless input is turned off (QWCIN = off) and OTG is active (QCHGIN = on). Battery is connected to support SYS and OTG loads (QBAT = on), and charger is operating in boost mode (boost = on). See Figure 12.

**No Charge Buck,** <u>MODE = 0x0C</u>: Adapter or wireless charger are detected, within the input voltage operating range (QCHGIN = on or QWCIN = on). Battery is disconnected (QBAT = off), and charger is operating in buck mode powering the SYS node. See Figure 13.

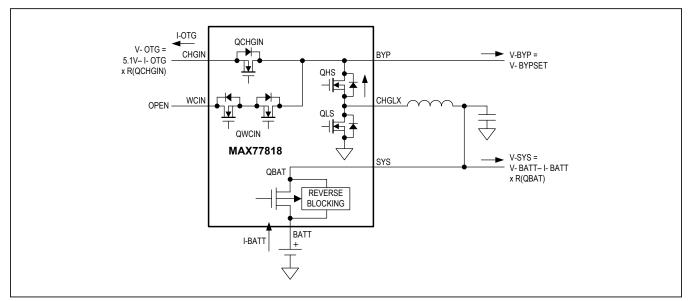


Figure 12. Battery Boost (OTG)

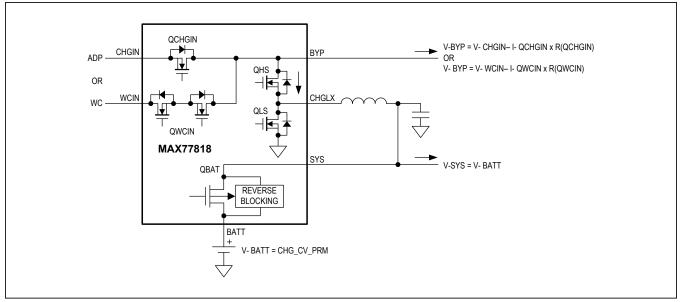


Figure 13. No Charge Buck

# Dual Input, Power Path, 3A Switching Mode Charger with FG

**Charge Buck, <u>MODE = 0x0D</u>:** Adapter or wireless charger are detected, within the input voltage operating range (QCHGIN = on or QWCIN = on). Battery is connected in charge mode (QBAT = on), and charger is operating in buck mode. See <u>Figure 14</u>. **No Change Buck (OTG),** <u>MODE = 0x0E</u>: Wireless charger is detected within the input voltage operating range (QWCIN = on) and OTG is active (QCHGIN = of). Battery is connected in charge mode (QBAT = on), and charger is operating in buck mode. See Figure 15.

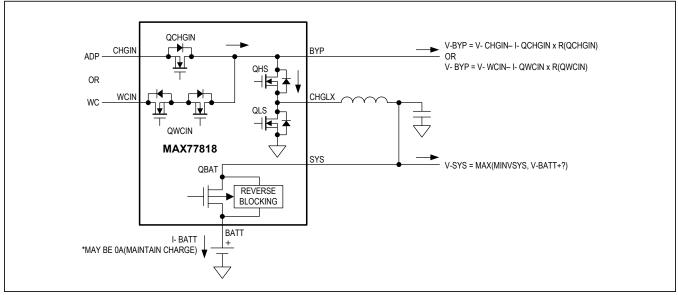


Figure 14. Charge Buck

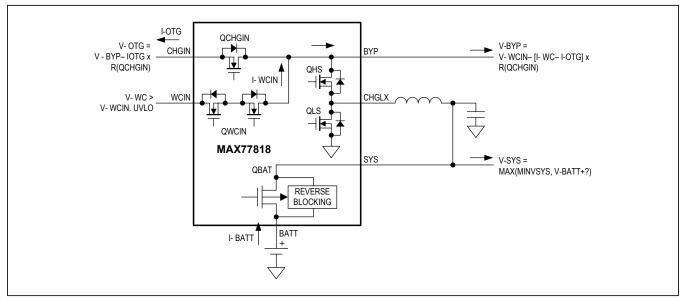


Figure 15. No Charge Buck (OTG)

**Charge Buck (OTG),** <u>MODE = 0x0F</u>: Wireless charger is detected within the input voltage operating range (QWCIN = on) and OTG is active (QCHGIN = on). Battery is connected in charge mode (QBAT = on), and charger is operating in buck mode powering the SYS node. See Figure 16.

#### Safeout LDOs

#### Safeout with Input Overvoltage Protection

The safeout LDOs are linear regulators that provides an output voltage of 3.3V, 4.85V, 4.9V, or 4.95V and can be used to supply low voltage rated USB systems. The SAFEOUT1 linear regulator turns on when CHGIN  $\geq$  CHGIN\_UVLO and ENSAFEOUT\_ = logic-high regardless of charger enable or DETBATB. SAFEOUT\_ is disabled when CHGIN is greater than the overvoltage threshold (13.7V typ). The safeout LDOs integrate high-voltage MOSFETs to provide 14V protection at their inputs, which are internally connected to the BYP.

SAFEOUT1 is default ON at 4.9V. SAFEOUT2 is default off.

#### **Fuel Gauge**

The MAX77818 incorporates the ModelGauge m5 algorithm that combines the excellent short-term accuracy and linearity of a coulomb counter with the excellent long-term stability of a voltage-based fuel gauge, along with temperature compensation to provide industry-leading fuel-gauge accuracy. ModelGauge m5 cancels offset accumulation

# Dual Input, Power Path, 3A Switching Mode Charger with FG

error in the coulomb counter, while providing better shortterm accuracy than any purely voltage-based fuel gauge. Additionally, the ModelGauge m5 algorithm does not suffer from abrupt corrections that normally occur in coulombcounter algorithms, since tiny continual corrections are distributed over time.

The device automatically compensates for aging, temperature, and discharge rate and provides accurate state of charge (SOC) in mAh or %, as well as time-to-empty over a wide range of operating conditions. The device provides two methods for reporting the age of the battery: reduction in capacity and cycle odometer.

The device provides precision measurements of current, voltage, and temperature. Temperature of the battery pack is measured using an external thermistor supported by ratiometric measurements on an auxiliary input. A 2-wire (I<sup>2</sup>C) interface provides access to data and control registers.

#### Features

- Accurate battery capacity and time-to-empty readings
- Estimation
  - Temperature, age, and rate Compensated
  - Does not require empty, full, or idle states to
- Maintain accuracy
  - Precision measurement system
  - No calibration required

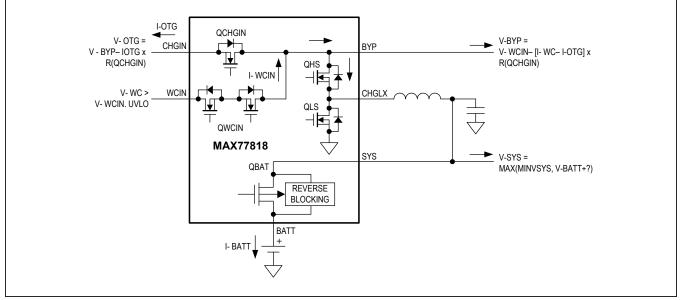


Figure 16. Charge-Buck (OTG)

- ModelGauge m5 algorithm
  - Long-term influence by voltage fuel gauge
- Cancels coulomb-counter drift
  Short-term influence by coulomb counter
  - Provides excellent linearity
  - · Adapts to cell characteristics
- External temperature-measurement network
  - · Actively switched thermistor resistive divider
  - Reduces current consumption
- Low quiescent current
- 25µA active, < 0.5µA shutdown</li>
- Alert Indicator for SOC, voltage, temperature, and battery removal/insertion events
- At rate estimation of remaining capacity

#### I<sup>2</sup>C Interface

The MAX77818 acts as a slave transmitter/receiver. The MAX77818 has the following slave address.

## Dual Input, Power Path, 3A Switching Mode Charger with FG

#### **Slave Addresses**

Charger : 0xD2/D3h

Clogic, GTEST and Safeout LDOs: 0xCCh/0xCDh

Fuel Gauge: 0x6C/0x6D. See the Fuel Gauge I<sup>2</sup>C Protocol for details in *Fuel Gauge* section.

#### I<sup>2</sup>C Bit Transfer

One data bit is transferred for each clock pulse. The data on SDA must remain stable during the high portion of the clock pulse as changes in data during this time are interpreted as a control signal.

#### I<sup>2</sup>C Start and Stop Conditions

Both SDA and SCL remain High when the bus is not busy. A high-to-low transition of SDA, while SCL is high is defined as the start (S) condition. A low-to-high transition of SDA while SCL is high is defined as the stop (P) condition.

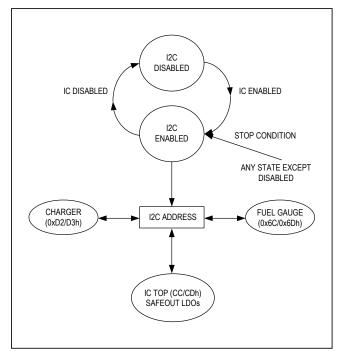
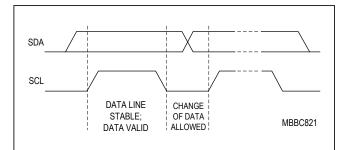
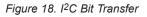


Figure 17. I<sup>2</sup>C Slave Address Structure





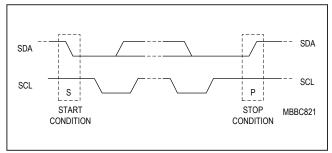


Figure 19. I<sup>2</sup>C Start and Stop

# Dual Input, Power Path, 3A Switching Mode Charger with FG

#### I<sup>2</sup>C System Configuration

A device on the I<sup>2</sup>C bus that generates a message is called a transmitter and a device that receives the message is a receiver. The device that controls the message is the master. The devices that are controlled by the master are called slaves.

#### I<sup>2</sup>C Acknowledge

The number of data bytes between the start and stop conditions for the transmitter and receiver are unlimited.

Each 8-bit byte is followed by an acknowledge bit. The acknowledge bit is a high-level signal put on SDA by the transmitter during the time the master generates an extra acknowledge-related clock pulse. A slave receiver that

is addressed must generate an acknowledge after each byte it receives. Also, a master receiver must generate an acknowledge after each byte it receives that has been clocked out of the slave transmitter.

The device that acknowledges must pull down the SDA line during the acknowledge clock pulse, so that the SDA line is stable low during the high period of the acknowledge clock pulse (set-up and hold times must also be met). A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this case, the transmitter must leave SDA high to enable the master to generate a stop condition.

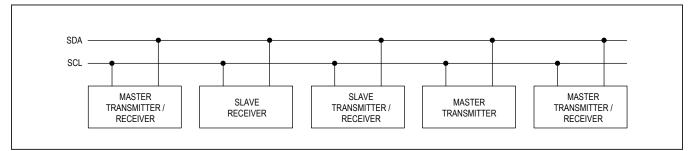


Figure 20. I<sup>2</sup>C System Configuration

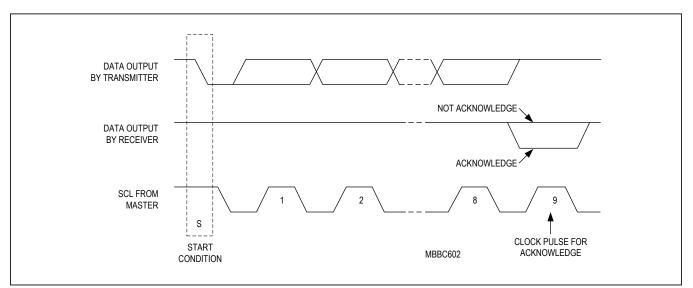
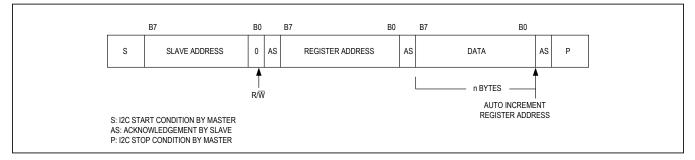


Figure 21. I<sup>2</sup>C Knowledge

# Dual Input, Power Path, 3A Switching Mode Charger with FG

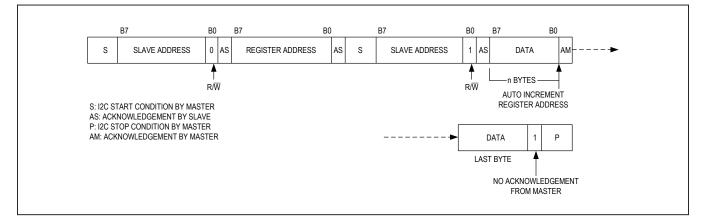
#### Master Transmits (Write Mode)

When master writes to slave, use the following format:



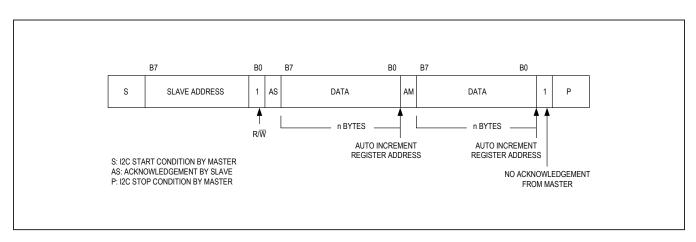
#### Master Reads After Setting Register Address (Write Register Address and Read Data)

When reading a specific register, use the following format:



#### Master Reads Register Data Without Setting Register Address (Read Mode)

When reading registers from the first address, use the following format:



#### I<sup>2</sup>C Register Map and Detail Descriptions

#### **Register Reset Conditions in R column**

Type S: Registers are reset each time when SYS < SYS POR (~1.55V)

**Type O:** Registers are reset each time when SYS < SYS UVLO (2.55V max) or SYS > SYS OVLO or Die temp > 165° (or MAX77818 transitions from on to off state)

#### Top Level I<sup>2</sup>C Registers

The MAX77818 acts as a slave transmitter/receiver. The slave address of the MAX77818 top is 0xCCh/0xCDh (OTP option for 0xDC/0xDDh). The least significant bit is the read/write indicator.

The MAX77818's tope level has the following registers:

#### **0x20: PMIC ID Register**

NAME	FUNCTION	ADDR	ТҮРЕ	RESET
PMICID	PMIC ID	0x20	0	0x23

BIT	MODE	NAME	RESET	DESCRIPTION
3:0	R	ID	0011	ID of MAX77818
7:4	R	ID	0010	

#### 0x21: PMIC Version/Rev Register

NAME	FUNCTION	ADDR	ТҮРЕ	RESET
PMICREV	PMIC revision	0x21	0	0x80

BIT	MODE	NAME	RESET	DESCRIPTION
2:0	R	REV		Pass 0b000 = pass 1 0b001 = pass 2 0b010 = pass 3
7:3	R	VERSION	_	Version 0b00000 = zmo 0b00001 = ymo  Null Trim Version 0b10000 = tmo 0b10001 = umo

# Dual Input, Power Path, 3A Switching Mode Charger with FG

#### **0x22: Interrupt Source**

NAME	FUNCTION	ADDR	ТҮРЕ	RESET
INTSRC	Interrupt source	0x22	S	0x00

BIT	MODE	NAME	RESET	DESCRIPTION
0	R	CHGR_INT	0	0: No charger interrupt. 1: Charger interrupt is detected.
1	R	FG_INT	0	0 = No interrupt pending from FG block. 1 = interrupt from FG block is detected .
2	R	SYS_INT	0	0: No SYS INT 1: SYS interrupt is detected.
3	R	RSVD	0	Reserved
4	R	RSVD	0	Reserved
5	R	RSVD	0	Reserved
6	R	RSVD	0	Reserved
7	R	RSVD	0	Reserved

## 0x23: Interrupt Source Mask

NAME	FUNCTION	ADDR	ТҮРЕ	RESET
INTSRCMASK	Interrupt source mask	0x23	S	0xFF

BIT	MODE	NAME	RESET	DESCRIPTION
0	R/W	CHGR_INT_MASK	1	1: Charger interrupt is masked.
1	R/W	FG_INT_MASK	1	1: FG interrupt is masked.
2	R/W	SYS_INT_MASK	1	1: SYS interrupt is masked.
3	R/W	RSVD	1	Reserved
4	R/W	RSVD	1	Reserved
5	R/W	RSVD	1	Reserved
6	R/W	RSVD	1	Reserved
7	R/W	RSVD	1	Reserved

# Dual Input, Power Path, 3A Switching Mode Charger with FG

#### **0x24: SYSTEM Interrupt**

NAME	FUNCTION	ADDR	ТҮРЕ	RESET
SYSINTSRC	SYS interrupt source	0x24	S	0x00

BIT	MODE	NAME	RESET	DESCRIPTION
0	R	SYSUVLO_INT	0	0: No SYSUVLO INT. 1: SYSUVLO interrupt is detected (falling).
1	R	SYSOVLO_INT	0	0: No SYSOVLO interrupt. 1: SYSOVLO interrupt is detected (rising and falling).
2	R	TSHDN_INT		0: No TSHDN interrupt. 1: TSHDN interrupt is detected.
3	R	RSVD	0	Reserved
4	R	RSVD	0	Reserved
5	R	RSVD	0	Reserved
6	R	RSVD	0	Reserved
7	R	TM_INT	0	0: Test mode interrupt is not set. 1: Test mode interrupt is set.

## 0x26: SYSTEM Interrupt Source Mask

NAME	FUNCTION	ADDR	ТҮРЕ	RESET
SYSINTMASK	System interrupt mask	0x26	S	0xFF

BIT	MODE	NAME	RESET	DESCRIPTION
0	R/W	SYSUVLO_INT_MASK	1	1: SYSUVLO interrupt is masked.
1	R/W	SYSOVLO_INT_MASK	1	1: SYSUVLO interrupt is masked.
2	R/W	TSHDN_INT_MASK	1	1: Thermal shutdown interrupt is masked.
3	R/W	RSVD	1	Reserved
4	R/W	RSVD	1	Reserved
5	R/W	RSVD	1	Reserved
6	R/W	RSVD	1	Reserved
7	R/W	TM_INT_MASK	0	1: INT test mode interrupt is masked.

## Dual Input, Power Path, 3A Switching Mode Charger with FG

#### **0xC6: SAFEOUT LDO Control**

NAME	FUNCTION	ADDR	ТҮРЕ	RESET
SAFEOUTCTRL	SAFEOUT linear regulator control	0xC6	0	0x75

BIT	MODE	NAME	RESET	DESCRIPTION
1:0	R/W	SAFEOUT1[1:0]	01	SAFEOUT1 output voltage 00: 4.85V 01: 4.90V (default) 10: 4.95V 11: 3.3V.
3:2	R/W	SAFEOUT2[3:2]	01	SAFEOUT2 output voltage 00: 4.85V 01: 4.90V (default) 10: 4.95V 11: 3.3V
4	R/W	ACTDISSAFE01	1	0: No active discharge 1: Active discharge
5	R/W	ACTDISSAFE02	1	0: No active discharge 1: Active discharge
6	R/W	ENSAFEOUT1	1	SAFEOUTLDO1 enable bit 0: Disable SAFEOUT1. 1: Enable SAFEOUT1.
7	R/W	ENSAFEOUT2	0	SAFEOUTLDO2 enable bit 0: Disable SAFEOUT2. 1: Enable SAFEOUT2.

#### Charger I<sup>2</sup>C Registers

The MAX77818's charger has convenient default register settings and a complete charger state machine that allow it to be used with minimal software interaction. Software interaction with the register map enhances the charger by allowing a high degree of configurability. An easy-tonavigate interrupt structure and in-depth status reporting allows software to quickly track the changes in the charger's status.

#### **Register Protection**

The CHG\_CNFG\_01, CHG\_CNFG\_02, CHG\_CNFG\_03, CHG\_CNFG\_04, CHG\_CNFG\_05, and CHG\_CNFG07 registers contain settings for static parameters that are associated with a particular system and battery. These static settings are typically set once each time the system's microprocessor runs its boot-up initialization code; then they are not changed again until the microprocessor re-boots. CHGPROT allows for blocking the "write" access to these static settings to protect them from being

changed unintentionally. This protection is particularly useful for critical parameters such as the battery charge current CHG\_CC and the battery charge voltage CHG\_ CV\_PRM

Determine the following registers bit settings by considering the characteristics of the battery. Maxim recommends that CHG\_CC be set to the maximum acceptable charge rate for your battery – there is typically no need to actively adjust the CHG\_CC setting based on the capabilities of the source at CHGIN, system load, or thermal limitations of the PCB; the smart power selector intelligently manages all these parameters to optimize the power distribution.

Charger Restart Threshold → CHG\_RSTRT

Fast-Charge Timer ( $t_{FC}$ )  $\rightarrow$  FCHGTIME

Fast-Charge Current → CHG\_CC

Top-Off Time → TO\_TIME

Top-Off Current → TO\_ITH

Battery Regulation Voltage → CHG\_CV\_PRM

## Dual Input, Power Path, 3A Switching Mode Charger with FG

State changes on any subblock report interrupts through

the CHG INT register. Interrupt sources are masked from affecting the hardware interrupt pin when bits in the CHG

INT\_MASK register are set. The CHG\_INT\_OK register

Determine the following register bit settings by considering the characteristics of the system:

Low Battery Prequalification Enable -> PQEN

Minimum System Regulation Voltage → MINVSYS

Junction Temperature Thermal Regulation Loop Setpoint → REGTEMP

#### Interrupt, Mask, OK, and Detail Registers

The battery charger section of the MAX77818 provides detailed interrupt generation and status for the following subblocks:

Charger Input Charger State Machine Battery

**Bypass Node** 

NAME

CHG INT

#### CHG\_INT Register Bit Description (0xB0) FUNCTION

Charger interrupt

ADDR

0xB0

TYPE

0

provides a single-bit status indication of whether the interrupt generating sub-block is okay or not. The full status of interrupt generating subblock is provided in the CHG\_ DETAILS 00, CHG DETAILS 01, CHG DETAILS 02, and CHG\_DETAILS\_03 registers. Note that CHG\_INT, CHG\_INT\_MASK and CHG\_INT\_OK

use the same bit position for each interrupt generating block to simplify software development.

Interrupt bits are automatically cleared upon reading a given interrupt register. When all pending CHG\_INT interrupts are cleared, the top level interrupt bit deasserts.

RESET

0x00

BIT	MODE	NAME	RESET	DESCRIPTION	
0	R/C	BYP_I	0	Bypass Node Interrupt 0 = The BYP_OK bit has not changed since the last time this bit was read. 1 = The BYP_OK bit has changed since the last time this bit was read.	
1	R/C	RSVD	0	Reserved	
2	R/C	BATP_I	0	Battery Presence Interrupt. 0 = The BATP_OK bit has not changed since the last time this bit was read. 1 = The BATP_OK bit has changed since the last time this bit was read.s	
3	R/C	BAT_I	0	Battery Interrupt 0 = The BAT_OK bit has not changed since the last time this bit was read. 1 = The BAT_OK bit has changed since the last time this bit was read.	
4	R/C	CHG_I	0	Charger Interrupt 0 = The CHG_OK bit has not changed since the last time this bit was read. 1 = The CHG_OK bit has changed since the last time this bit was read.	
5	R/C	WCIN_I	0	WCIN Interrupt. 0 = The WCIN_OK bit has not changed since the last time this bit was read. 1 = The WCIN_OK bit has changed since the last time this bit was read.	
6	R/C	CHGIN_I	0	CHGIN Interrupt. 0 = The CHGIN_OK bit has not changed since the last time this bit was read. 1 = The CHGIN_OK bit has changed since the last time this bit was read.	
7	R/C	AICL_I	0	AICL interrupt 0=The AICL_OK bit has not changed since the last time this bit was read. 1=The AICL_OK bit has changed since the last time this bit was read.	

# Dual Input, Power Path, 3A Switching Mode Charger with FG

# CHG\_INT\_MASK Register Bit Description (0xB1)

NAME	FUNCTION	ADDR	ТҮРЕ	RESET
CHG_INT_MASK	Charger interrupt mask	0xB1	0	0xFF

BIT	MODE	NAME	RESET	DESCRIPTION
0	R/W	BYP_M	1	Bypass Interrupt Mask 0 = Unmasked 1 = Masked
1	R/W	RSVD	1	Reserved
2	R/W	BATP_M	1	Battery Presence Interrupt Mask 0 = Unmasked 1 = Masked
3	R/W	BAT_M	1	Battery Interrupt Mask 0 = Unmasked 1 = Masked
4	R/W	CHG_M	1	Charger Interrupt Mask 0 = Unmasked 1 = Masked
5	R/W	WCIN_M	1	WCIN Interrupt Mask 0 = Unmasked 1 = Masked
6	R/W	CHGIN_M	1	CHGIN Interrupt Mask 0 = Unmasked 1 = Masked
7	R/W	AICL_M	1	AICL Interrupt Mask 0 = Unmasked 1 = Masked

# Dual Input, Power Path, 3A Switching Mode Charger with FG

#### CHG\_INT\_OK Register Bit Description (0xB2)

N	AME	FUNCTION	ADDR	ТҮРЕ	RESET			
CHG_	INT_OK	Charger status	0xB2	0	0x00			
BIT	MODE	NAME	RESET	DESCRIPTION				
0	R	BYP_OK	0	Single-Bit Bypass Status Indicator. See BYP_D <sup>-</sup> 0 = Something powered by the bypass node has DTLS ≠ 0x00. 1 = The bypass node is okay. i.e., BYP_DTLS = 0x00.				
1	R	RSVD	0	Reserved				
2	R	BATP_OK	0	BAT present status indicator. 0 = Main Battery is not present 1 = Main Battery is present.	0 = Main Battery is not present			
3	R	BAT_OK	0	Single-Bit Battery Status Indicator. See BAT_DTLS for more information. 0 = The battery has an issue or the charger has been suspended, i.e., BAT_ DTLS ≠ 0x03 or 0x04 1 = The battery is okay. i.e., BAT_DTLS = 0x03 or 0x04				
4	R	CHG_OK	0	Single-Bit Charger Status Indicator. See CHG_DTLS for more information. 0 = The charger has suspended charging or TREG = 1 i.e., CHG_DTLS ≠ 0x00 or 0x01 or 0x02 or 0x03 or 0x05 or 0x08 1 = The charger is okay or the charger is off i.e., CHG_DTLS = 0x00 or 0x01 or 0x02 or 0x03 or 0x05 or 0x08				
5	R	WCIN_OK	0	Single-Bit WCIN Input Status Indicator. See WCIN_DTLS for more information. 0 = The WCIN input is invalid. i.e., WCIN_DTLS ≠ 0x03. 1 = The WCIN input is valid. i.e., WCIN_DTLS = 0x03.				
6	R	CHGIN_OK	0	Single-Bit CHGIN Input Status Indicator. See CHGIN_DTLS for more information. 0 = The CHGIN input is invalid. i.e., CHGIN_DTLS ≠ 0x03. 1 = The CHGIN input is valid. i.e., CHGIN_DTLS = 0x03.				
7	R	AICL_OK	0	AICL_OK 0 = AICL mode 1 = Not in AICL mode				

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#### CHG\_DETAILS\_00 Register Bit Description (0xB3)

NAME	FUNCTION	ADDR	ТҮРЕ	RESET
CHG_DTLS_00	Charger details 00	0xB3	0	0x00

BIT	MODE	NAME	RESET	DESCRIPTION
0	R	BATP_DTLS	0	Battery Detection 0 = Battery presence 1 = No battery presence
2:1	R	RSVD	00	Reserved
4:3	R	WCIN_DTLS	00	WCIN Details 0x00 = VWCIN is invalid. V <sub>WCIN</sub> < V <sub>WCIN</sub> _UVLO 0x01 = VWCIN is invalid. V <sub>WCIN</sub> < V <sub>MBAT</sub> + V <sub>WCIN2SYS</sub> and V <sub>WCIN</sub> > V <sub>WCIN</sub> _UVLO 0 x 02 = VWCIN is invalid. V <sub>WCIN</sub> >V <sub>WCIN</sub> _OVLO 0 x 03 = VWCIN is valid. V <sub>WCIN</sub> > V <sub>WCIN</sub> _UVLO, V <sub>WCIN</sub> > V <sub>MBAT</sub> + V <sub>WCIN2SYS</sub> , V <sub>WCIN</sub> < V <sub>WCIN</sub> _OVLO
6:5	R	CHGIN_DTLS	00	CHGIN Details 0x00 = VBUS is invalid. V <sub>CHGIN</sub> < V <sub>CHGIN</sub> _UVLO 0x01 = VBUS is invalid. V <sub>CHGIN</sub> < V <sub>MBAT</sub> + V <sub>CHGIN2SYS</sub> and V <sub>CHGIN</sub> > V <sub>CHGIN</sub> _UVLO 0x02 = VBUS is invalid. V <sub>CHGIN</sub> > V <sub>CHGIN</sub> _OVLO 0x03 = VBUS is valid. V <sub>CHGIN</sub> > V <sub>CHGIN</sub> _UVLO, V <sub>CHGIN</sub> > V <sub>MBAT</sub> + V <sub>CHGIN2SYS</sub> , V <sub>CHGIN</sub> < V <sub>CHGIN</sub> _OVLO
7	R	RSVD	0	Reserved

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## CHG\_DETAILS\_01 Register Bit Description (0xB4)

NAME	FUNCTION	ADDR	ТҮРЕ	RESET
CHG_DTLS_01	Charger details 01	0xB4	0	0x00

BIT	MODE	NAME	RESET	DESCRIPTION
3:0	R	CHG_DTLS	0000	Charger Details $0x00 = charger is in dead-battery prequalification or low-battery prequalification mode, CHG_OK = 1, VMBATT < VPQLB, TJ < TJSHDN 0x01 = charger is in fast-charge constant current mode, CHG_OK = 1, VMBATT < VBATREG, TJ < TJSHDN 0x02 = charger is in fast-charge constant voltage mode, CHG_OK = 1, VMBATT = VBATREG, TJ < TJSHDN 0x03 = charger is in top-off mode, CHG_OK = 1, VMBATT > VBATREG, TJ < TJSHDN 0x03 = charger is in top-off mode, CHG_OK = 1, VMBATT > VBATREG, TJ < TJSHDN 0x04 = charger is in done mode, CHG_OK=0, VMBATT > VBATREG - VRSTRT, TJ < TJSHDN 0x06 = charger is in timer fault mode, CHG_OK = 0, VMBATT < VBATOV, if BAT_DTLS = 0b001 then VMBATT < VBATPQ, TJ < TJSHDN 0x07 = charger is in DETBAT = High suspend mode, CHG_OK = 0,V_{MBATT} < V_{BATOV}, if BAT_DTLS = 0b001 then VMBATT < VPQLB, TJ < TJSHDN0x08 = Charger is off, charger input invalid and/or charger is disabled, CHG_OK = 1.0x09 = Reserved0x0A = Charger is off and the junction temperature is > TJSHDN, CHG_OK = 0.0x0B = Charger is off because the watchdog timer expired, CHG_OK = 0.0x0C-0x0F = Reserved$
6:4	R	BAT_DTLS	000	Battery Details 0x00 = No battery and the charger is suspended. $0x01 = V_{MBATT} < V_{PQLB}$ . This condition is also reported in the CHG_DTLS as 0x00 0x02 = the battery is taking longer than expected to charge. This could be due to high system currents, an old battery, a damaged battery or something else. Charging has suspended and the charger is in its timer fault mode. This condition is also reported in the CHG_DTLS as 0x06. 0x03 = the battery is okay and its voltage is greater than the minimum system voltage ( $V_{SYSMIN} < V_{MBATT}$ ), QBAT is on and $V_{SYS}$ is approximately equal to $V_{MBATT}$ . $0x04 =$ the battery is okay but its voltage is low: $V_{PQLB} < V_{MBATT} < V_{SYSMIN}$ . $Q_{BAT}$ is operating like an LDO to regulate $V_{SYS}$ to $V_{SYSMIN}$ . 0x05 = the battery voltage is greater than the battery overvoltage flag threshold ( $V_{BATOVF$ ) or it has been greater than this threshold within the last 37.5ms. $V_{BATOVF}$ is set to a percentage above the $V_{BATREG}$ target as programmed by CHG_CV_PRM. Note that this flag is only be generated when there is a valid input or when the DC- DC is operating as a boost. 0x06 = the battery is overcurrent or it has been overcurrent for at least 6ms since the last time this register has been read. 0x07 = Reserved In the event that multiple faults occur within the battery details category, overcurrent has priority followed by no battery, then overvoltage, then timer fault, then below prequel.

# Dual Input, Power Path, 3A Switching Mode Charger with FG

#### CHG\_DETAILS\_01 Register Bit Description (0xB4) (continued)

BIT	MODE	NAME	RESET	DESCRIPTION
7	R	TREG	0	Temperature Regulation Status 0 = The junction temperature is less than the threshold set by REGTEMP and the full charge current limit is available. 1 = The junction temperature is greater than the threshold set by REGTEMP and the charge current limit may be folding back to reduce power dissipation.

#### CHG\_DETAILS\_02 Register Bit Description (0xB5)

NAME	FUNCTION	ADDR	ТҮРЕ	RESET
CHG_DTLS_02	Charger details 02	0xB5	0	0x00

BIT	MODE	NAME	RESET	DESCRIPTION
3:0	R	BYP_DTLS	0000	Bypass Node Details. All bits in this family are independent from each other. They are grouped together only because they all relate to the health of the BYP node and any change in these bits generates a BYP_I interrupt. BYP_DTLS0 = OTGILIM = <b>0bxxx1</b> BYP_DTLS1 = BSTILIM = <b>0bxx1x</b> BYP_DTLS2 = BCKNegILIM = <b>0bx1xx</b> **********************************
7:4	R	RSVD	00	Reserved

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#### CHG\_CNFG\_00 Register Bit Description (0xB7)

N	IAME	FUNCTION		ADDR	ТҮРЕ	RESET
CHG_	CNFG_00	Charger conf 00	iguration	0xB7	0	0x05
BIT	MODE	NAME	RESET	DESCRIP	ΓΙΟΝ	
3:0	R/W	MODE	0101	0x00 = 0b0 on to allow on the CH4 0x01 = 0b0 0x02 = 0b0 0x03 = 0b0 valid input, 0x05 = 0b0 valid input, $V_{SYS}$ is the 0x06 = 0b0 0x07 = 0b0 $0x08 = 0b^2$ is on to allo a boost conv $0x09 = 0b^2$ $0x0A = 0b^2$ is on to allo boost conv The boost 0x0B = rest $0x0B = rest0x0C = 0ba valid inputand \sim V_{MB},target volta0x0E = 0bvalid WCINis on, allowinvalid the0x0F = 0b^2a valid WCINis on, allowinvalid the0x0F = 0b^2a valid WCINis on, allow$	ver Selector Configuration 0000 = charger = off, OTG = off, buck = off, I the battery to support the system. BYP may GIN availability. $0001 = same as 0b00000010 = same as 0b00000010 = charger = off, OTG = off, buck = on, the buck converter regulates the system vol- 0101 = charger = on, OTG = off, buck = on,the battery is charging.e larger of VSYSMIN and ~VMBATT + IMBATT0101 = same as 0b1010100 = charger = off, OTG = off, buck = off, I 0000 = charger = off, OTG = off, buck = off, I 0000 = charger = off, OTG = off, buck = off, I tow the battery to support the system and the nverter. The BYP voltage is regulated to VB 1001=same as 0b10001010 = charger = off, OTG = on, buck = off, I tow the battery to support the system, the ch- verter. QCHGIN is on allowing it to source cu- target voltage is 5.1V (VBYP.OTG). Herved 1100 = charger = off, OTG = off, buck = on,ut, the system is supported from that input. Nboost is on with a target voltage that is VBY1101 = charger = on, OTG = off, buck = on,ut, the system is supported from that input. Nboost is on with a target voltage that is VBY1101 = charger = on, OTG = on, buck = on,ut, the system is supported from that input. NATT + I_{MBATT} \times R_{BAT2SYS}. When input is inva-age that is VBYPSET1110=charger=off, OTG = on, buck = on,unput, the system is supported from that input. N boost is on with a target voltage of 5.1V (VE 1111 = charger = on, OTG = on, buck = on,UNBATT + I_{MBATT} \times R_{BAT2SYS}. QCHGI1CHGIN.OTG.MAX. When WCIN input is inage of 5.1V (V_{BYP.OTG})$	y or may not be biased based boost = off. When there is a bltage to be V <sub>BATREG</sub> . boost = off. When there is a "x RBAT2SYS. boost = on. The Q <sub>BAT</sub> switch e charger's DC-DC operates as YPSET. QCHGIN is off boost = on. The Q <sub>BAT</sub> switch arger's DC-DC operates as a rrent up to I <sub>C</sub> HGIN.OTG.MAX. boost = on. When there is $V_{SYS} = 4.2V$ . When input is 'PSET a, boost = on. When there is $V_{SYS}$ is the larger of V <sub>SYSMIN</sub> valid the boost is on with a post = on. When there is a put: V <sub>SYS</sub> = 4.2V and QCHGIN MAX. When WCIN input is BYP.OTG). boost = on. When there is input: V <sub>SYS</sub> is the larger of N is on allowing it to source

# Dual Input, Power Path, 3A Switching Mode Charger with FG

#### CHG\_CNFG\_00 Register Bit Description (0xB7) (continued)

BIT	MODE	NAME	RESET	DESCRIPTION
4	R/W	WDTEN	0	Watchdog Timer Enable Bit. While enabled, the system controller must reset the watchdog timer within the timer period ( $t_{WD}$ ) for the charger to operate normally. Reset the watchdog timer by programming WDTCLR = 0x01. 0 = Watchdog Timer disabled 1 = Watchdog Timer enabled
5	R/W	SPREAD	0	Spread Spectrum Feature Feature is operational both for 9V and 12V CHGIN input voltage. Feature is not guaranteed to be operational for 5V CHGIN/WCIN input voltage. When feature is not operational, it can be kept enabled without side effect. 0: Disabled 1: Enabled
6	R/W	DISIBS	0	MBATT to SYS FET Disable Control 0 = MBATT to SYS FET is controlled by the power path state machine. 1 = MBATT to SYS FET is forced off.
7	R/W	OTG_CTRL	0	OTG FET Control 0 = Forces the CHGIN input switch to be on when in Mode = 0x0E or 0x0F. 1 = The CHGIN turns off anytime power switches between WCIN and BATT.

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## CHG\_CNFG\_01 Register Bit Description (0xB8)

N	IAME	FUNCTION	ADDR	ТҮРЕ	RESET
CHG_	CNFG_01	Charger details 01	0xB8	O R/W (protected with CHGPROT)	0x10
BIT	MODE	NAME	RESET	DESCRIPTION	
2:0	R/W	FCHGTIME	001	Fast-Charge Timer Duration $(t_{FC})$ 0x00 = disable 0x01 = 4hrs 0x02 = 6hrs 0x03 = 8hrs 0x04 = 10hrs 0x05 = 12hrs 0x06 = 14hrs 0x07 = 16hrs	
3	R/W	FSW	0     Switching Frequency Option       0     0: 4MHz       1: 2MHz		
5:4	R/W	CHG_RSTRT	01	Charger Restart Threshold 0x00 = 100mV below the value prograr 0x01 = 150mV below the value prograr 0x02 = 200mV below the value prograr 0x03 = Disabled	mmed by CHG_CV_PRM
6	R/W	LSEL	Inductor Selection 0:0.47µH (for 4MHz without restriction) 2MHz/0.47µH option can be used only in the charge mode and is forbidden in following use cases: Boost mode Buck mode 1:1µH (for 2MHz and 4MHz option)		
7	R/W	PQEN	0       Low Battery Prequalification Mode Enable         0       0 = Low battery prequalification mode is disabled.         1 = Low battery prequalification mode is enabled.		

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#### CHG\_CNFG\_02 Register Bit Description (0xB9)

N	AME	FUNCTION	ADDR	TYPE					RESET		
CHG_0	CNFG_02	Charger configuration 02	0xB9	O R/W (protected with CHGPROT) 0x09							
BIT	MODE	NAME	RESET	DESCR	PTION						
			Fast-Charge Current Selection. When the charger is enabled, the charge current limit is set by these bits. These bits range from 0.10A (0x00) to 3.0A (0x3C) in 50mA step. Note that the first 3 codes are all 100mA								
				Bits	(mA)	Bits	(mA)	Bits	(mA)	Bits	(mA)
				0x00	100	0x10	800	0x20	1600	0x30	2400
				0x01	100	0x11	850	0x21	1650	0x31	2450
				0x02	100	0x12	900	0x22	1700	0x32	2500
				0x03	150	0x13	950	0x23	1750	0x33	2550
				0x04	200	0x14	1000	0x24	1800	0x34	2600
				0x05	250	0x15	1050	0x25	1850	0x35	2650
			001001	0x06	300	0x16	1100	0x26	1900	0x36	2700
5:0	R/W	CHG_CC	(450mA)	0x07	350	0x17	1150	0x27	1950	0x37	2750
				0x08	400	0x18	1200	0x28	2000	0x38	2800
				0x09	450	0x19	1250	0x29	2050	0x39	2850
				0x0A	500	0x1A	1300	0x2A	2100	0x3A	2900
				0x0B	550	0x1B	1350	0x2B	2150	0x3B	2950
				0x0C	600	0x1C	1400	0x2C	2200	0x3C	3000
				0x0D	650	0x1D	1450	0x2D	2250	0x3D	3000
				0x0E	700	0x1E	1500	0x2E	2300	0x3E	3000
				0x0F	750	0x1F	1550	0x2F	2350	0x3F	3000
					it the therr		ck loop ca	n reduce	the battery	charger's	s target
7:6	R/W	OTG_ILIM	00	CHGIN 0 When M current I 00 = 500 01 = 900 10 =120 11 = 150	ODE = 0x imit: 0mA 0mA 0mA	rrent Limit 09 or 0x0/	in OTG M A the CHG	lode (I <sub>CI</sub> iIN curre	HGIN.OTG.LI nt limit is se	<sub>M</sub> ) et at the fo	llowing

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# CHG\_CNFG\_03 Register Bit Description (0xBA):

NAME	FUNCTION	ADDR	ТҮРЕ	RESET
CHG_CNFG_03	Charger configuration 03	0xBA	O R/W (protected with CHGPROT)	0xDA

BIT	MODE	NAME	RESET	DESCRIPTION
2:0	R/W	то_ітн	010 (150mA)	Top-Off Current Threshold. The charger transitions from its fast-charge constant voltage mode to its top-off mode when the charger current decays to the value programmed by this register. This transition generates a CHG_I interrupt and causes the CHG_DTLS register to report top-off mode. This transition also starts the top-off time as programmed by TO_TIME. 0x00 = 0.1A 0x01 = 0.125A 0x02 = 0.15A 0x03 = 0.175A 0x04 = 0.2A 0x05 = 0.25A 0x06 = 0.3A 0x07 = 0.35A
5:3	R/W	TO_TIME	011 (30min)	Top-Off Timer Setting 0x00 = 0min 0x01 = 10min 0x02 = 20min 0x03 = 30min 0x04 = 40min 0x05 = 50min 0x05 = 60min 0x07 = 70min
7:6	R/W	ILIM	11	Program Buck Peak Current Limit 00: support ICHG=3.00A 01: support ICHG=2.75A 10: support ICHG= 2.50A 11: support ICHG=2.25A

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#### CHG\_CNFG\_04 Register Bit Description (0xBB):

NAME	FUNCTION	ADDR	ТҮРЕ	RESET
CHG_CNFG_04	Charger configuration 04	0xBB	O R/W (protected with CHGPROT)	0x96

BIT	MODE	NAME	RESET	DESCRIPT	ION				
			Primary Charge Termination Voltage SettingWhen the charger is enabled and the main-battery temperature is < T3 if						
				0x00	3.650	0x10	4.050	0x20	4.425
				0x01	3.675	0x11	4.075	0x21	4.450
				0x02	3.700	0x12	4.100	0x22	4.475
				0x03	3.725	0x13	4.125	0x23	4.500
				0x04	3.750	0x14	4.150	0x24	4.525
5:0	R/W	CHG_CV_PRM	010110	0x05	3.775	0x15	4.175	0x25	4.550
		(4.2V)	0x06	3.800	0x16	4.200	0x26	4.575	
				0x07	3.825	0x17	4.225	0x27	4.600
				0x08	3.850	0x18	4.250	0x28	4.625
				0x09	3.875	0x19	4.275	0x29	4.650
				0x0A	3.900	0x1A	4.300	0x2A	4.675
				0x0B	3.925	0x1B	4.325	0x2B	4.700
				0x0C	3.950	0x1C	4.340		
				0x0D	3.975	0x1D	4.350		
				0x0E	4.000	0x1E	4.375		
				0x0F	4.025	0x1F	4.400		
7:6	R/W	MINVSYS	10 (3.6V)	Minimum Sy 0x00 = 3.4V 0x01 = 3.5V 0x02 = 3.6V 0x03 = 3.7V	   	ation Voltage	(V <sub>SYSMIN</sub> )		

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#### CHG\_CNFG\_06 Register Bit Description (0xBD):

N	AME	FUNCTION	ADDR	ТҮРЕ	RESET
CHG_	CNFG_06	Charger configuration 06	0xBD	0	0x00
[	1		1		
BIT	MODE	NAME	RESET	DESCRIPTION	
1:0	R/W	WDTCLR	00	<ul> <li>Watchdog Timer Clear Bits</li> <li>Writing 01 to these bits clears the watchdog timer when the watchdog timer is enabled.</li> <li>0x00 = the watchdog timer is not cleared</li> <li>0x01 = the watchdog timer is cleared</li> <li>0x02 = the watchdog timer is not cleared</li> <li>0x03 = the watchdog timer is not cleared</li> </ul>	
3:2	R/W	CHGPROT	00	Charger Settings Protection Bits Writing 11 to these bits unlocks the write capability for the registers who are protected with CHGPROT writing any value besides 11 locks these registers	
7:4	R/W	RSVD	0000	Reserved	

#### CHG\_CNFG\_07 Register Bit Description (0xBE):

NAME	FUNCTION	ADDR	ТҮРЕ	RESET
CHG_CNFG_07	Charger configuration 07	0xBE	O R/W (protected with CHGPROT)	0x40

BIT	MODE	NAME	RESET	DESCRIPTION
4:0	R/W	RSVD	00000	Reserved
6:5	R/W	REGTEMP	10	Junction Temperature Thermal Regulation Loop Set point. The charger's target current limit starts to foldback and the TREG bit is set if the junction temperature is greater than the REGTEMP setpoint. 0x00 = 85°C 0x01 = 100°C 0x02 = 115°C 0x03 = 130°C
7	R/W	RSVD	0	Reserved

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#### CHG\_CNFG\_09 Register Bit Description (0xC0):

NAME		FUNCTION	ADDR	TYPE RESET								
CHG_CNFG_09		Charger configuration 09	0xC0	0				(	0x0F			
BIT	MODE	NAME	RESET	DESCR	DESCRIPTION							
				Maximum Input Current Limit Selection 7-bit adjustment from 100mA to 4.0A in 33mA steps. Note that the first 4 codes are all 100mA:								
				Bits	Unit (mA)	Bits	Unit (mA)	Bits	Unit (mA)	Bits	Unit (mA)	
				0x00	100	0x20	1067	0x40	2133	0x60	3200	
				0x01	100	0x21	1100	0x41	2167	0x61	3233	
				0x02	100	0x22	1133	0x42	2200	0x62	3267	
				0x03	100	0x23	1167	0x43	2233	0x63	3300	
				0x04	133	0x24	1200	0x44	2267	0x64	3333	
				0x05	167	0x25	1233	0x45	2300	0x65	3367	
				0x06	200	0x26	1267	0x46	2333	0x66         3400           0x67         3433           0x68         3467           0x69         3500	3400	
				0x07	233	0x27	1300	0x47	2367		3433	
		0x08 267 0x28 1333 0	0x48	2400	0x68	3467						
				0x09	300	0x29	1367	0x49	2433	0x69	3500	
		0x0A	333	0x2A	1400	0x4A	2467	0x6A	3533			
				0x0B	367	0x2B	1433	0x4B	2500	0x6B	0x6B 3567	
			0.05	0x0C	400	0x2C	1467	0x4C	2533	0x6C 3600		
6:0	R/W	CHGIN_ILIM	0x0F (0.50A)	0x0D	433	0x2D	1500	0x4D	2567	0x6D	3633	
			(0.50A)	0x0E	467	0x2E	1533	0x4E	2600	0x6E	3400 3433 3467 3500 3533 3567 3600 3633 3667 3700 3733 3767 3800 3833	
				0x0F	500	0x2F	1567	0x4F	2633	0x6F	3700	
				0x10	533	0x30	1600	0x50	2667	0x70	3733	
				0x11	567	0x31	1633	0x51		0x71	3767	
				0x12	600	0x32	1667	0x52		0x72	3800	
		0x13         633         0x33         1700           0x14         667         0x34         1733           0x15         700         0x35         1767		0x13	633	0x33	1700	0x53	2767	0x73	3833	
			1733	0x54	2800	0x74	3867					
			0x55	2833	0x75	3900						
				0x16	733	0x36	1800	0x56	2867	0x76	3933	
				0x17	767	0x37	1833	0x57	2900	0x77	3967	
				0x18	800	0x38	1867	0x58	2933	0x78	4000	
				0x19	833	0x39	1900	0x59	2967	0x79	4000	
				0x1A	867	0x3A	1933	0x5A	3000	0x7A	4000	
				0x1B	900	0x3B	1967	0x5B	3033	0x7B	4000	
				0x1C	933	0x3C	2000	0x5C	3067	0x7C	4000	
				0x1D	967	0x3D	2033	0x5D	3100	0x7D	4000	
				0x1E	1000	0x3E	2067	0x5E	3133	0x7E	4000	
				0x1F	1033	0x3F	2100	0x5F	3167	0x7F	4000	
7	R/W	RSVD	0	Reserve	d							

# Dual Input, Power Path, 3A Switching Mode Charger with FG

# CHG\_CNFG\_10 Register Bit Description (0xC1):

NAME	FUNCTION	ADDR	ТҮРЕ	RESET
CHG_CNFG_10	Charger configuration 09	0xC1	0	0x19

BIT	MODE	NAME	RESET	DESCRIPTION					
				Maximum Input Current Limit Selection 6bit adjustment from 60mA to 1.260A in 20mA steps. Note that the first 4 codes are all 60mA:					
				Bits	(mA)	Bits	(mA)		
				0x00	60	0x20	640		
				0x01	60	0x21	660		
				0x02	60	0x22	680		
				0x03	60	0x23	700		
				0x04	80	0x24	720		
				0x05	100	0x25	740		
				0x06	120	0x26	760		
				0x07	140	0x27	780		
				0x08	160	0x28	800		
				0x09	180	0x29	820		
				0x0A	200	0x2A	840		
				0x0B	220	0x2B	860		
				0x0C	240	0x2C	880		
			0x19	0x0D	260	0x2D	900		
5:0	R/W	WCIN_ILIM	(0.50A)	0x0E	280	0x2E	920		
				0x0F	300	0x2F	940		
				0x10	320	0x30	960		
				0x11	340	0x31	980		
				0x12	360	0x32	1000		
				0x13	380	0x33	1020		
				0x14	400	0x34	1040		
				0x15	420	0x35	1060		
				0x16	440	0x36	1080		
				0x17	460	0x37	1100		
				0x18	480	0x38	1120		
				0x19	500	0x39	1140		
				0x1A	520	0x3A	1160		
				0x1B	540	0x3B	1180		
				0x1C	560	0x3C	1200		
				0x1D	580	0x3D	1220		
				0x1E	600	0x3E	1240		
				0x1F	620	0x3F	1260		
7:6	R/W	RSVD	00	Reserved					

# Dual Input, Power Path, 3A Switching Mode Charger with FG

# CHG\_CNFG\_11 Register Bit Description (0xC2):

NAME		FUNCTION	ADDR	TYPE RESET							
CHG_CNFG_11 Charger configuration 11		0xC2	0					0x00			
BIT	MODE	NAME	RESET	DESCR	IPTION						
				Bypass Target Output Voltage in Boost Mode 3V (0x00) to 5.8V (0x70) in 0.025V steps. This setting is valid for the "boost only" mode (MODE = 0x08).							
				Bits	Unit (mA)	Bits	Unit (mA)	Bits	Unit (mA)	Bits	Unit (mA)
				0x00	3.000	0x20	3.800	0x40	4.600	0x60	5.400
				0x01	3.025	0x21	3.825	0x41	4.625	0x61	5.425
				0x02	3.050	0x22	3.850	0x42	4.650	0x62	5.450
				0x03	3.075	0x23	3.875	0x43	4.675	0x63	5.475
				0x04	3.100	0x24	3.900	0x44	4.700	0x64	5.500
				0x05	3.125	0x25	3.925	0x45	4.725	0x65	5.525
				0x06	3.150	0x26	3.950	0x46	4.750	0x66	5.550
				0x07	3.175	0x27	3.975	0x47	4.775	0x67	5.575
		0x08         3.200         0x28         4.000         0x48         4           0x09         3.225         0x29         4.025         0x49         4	4.800	0x68	5.600						
			4.825	0x69	5.625						
			4.850	0x6A	5.650						
			0x0B         3.275         0x2B         4.075         0x4B         4.875         0           0x0C         3.300         0x2C         4.100         0x4C         4.900         0	0x6B	5.675						
				0x0C	3.300	0x2C	4.100	0x4C	4.900	0x6C	5.700
6:0	R/W	VBYPSET	0x00	0x0D	3.325	0x2D	4.125	0x4D	4.925	0x6D	5.725
			(3V)	0x0E	3.350	0x2E	4.150	0x4E	4.950	0x6E	5.750
				0x0F	3.375	0x2F	4.175	0x4F	4.975		
				0x10	3.400	0x30	4.200	0x50	5.000		
				0x11	3.425	0x31	4.225	0x51	5.025		
				0x12	3.450	0x32	4.250	0x52	5.050		
				0x13	3.475	0x33	4.275	0x53	5.075		
		0x14 3.500 0x34 4.300	0x54	5.100							
				0x15	3.525	0x35	4.325	0x55	5.125		
				0x16	3.550	0x36	4.350	0x56	5.150		
				0x17	3.575	0x37	4.375	0x57	5.175		
				0x18	3.600	0x38	4.400	0x58	5.200		
				0x19	3.625	0x39	4.425	0x59	5.225		
				0x1A	3.650	0x3A	4.450	0x5A	5.250		
				0x1B	3.675	0x3B	4.475	0x5B	5.275		
				0x1C	3.700	0x3C	4.500	0x5C	5.300		
				0x1D	3.725	0x3D	4.525	0x5D	5.325		
				0x1E	3.750	0x3E	4.550	0x5E	5.350		
				0x1F	3.775	0x3F	4.575	0x5F	5.375		
7	R/W	RSVD	0	Reserve	d						

# Dual Input, Power Path, 3A Switching Mode Charger with FG

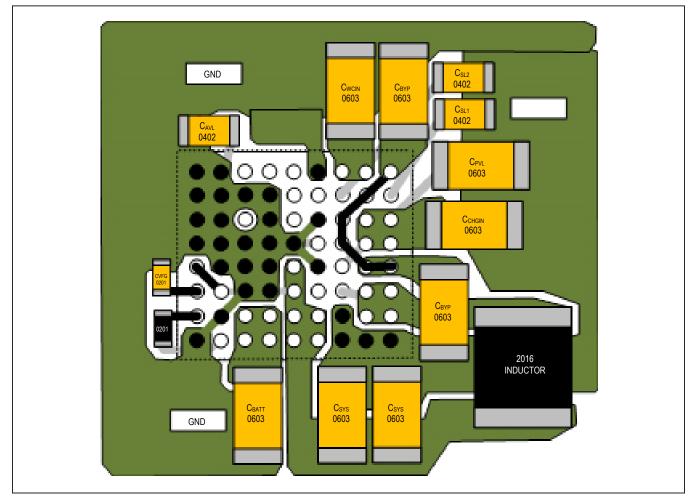
## CHG\_CNFG\_12 Register Bit Description (0xC3):

NAME	FUNCTION	ADDR	ТҮРЕ	RESET
CHG_CNFG_12	Charger configuration 12	0xC3	0	0x67

BIT	MODE	NAME	RESET	DESCRIPTION
2:0	R/W	B2SOVRC	111	BAT to SYS Overcurrent Threshold 0x00 = Disabled 0x01 = 3.00A 0x02 = 3.25A 0x03 = 3.50A 0x04 = 3.75A 0x05 = 4.00A 0x06 = 4.25A 0x07 = 4.50A
4:3	R/W	VCHGIN_REG	00	CHGIN Voltage Regulation Threshold ( $V_{CHGIN\_REG}$ ) Adjustment The CHGIN to GND Minimum Turn-On Threshold ( $V_{CHGIN\_UVLO}$ ) also scales with this adjustment. $0x00 = V_{CHGIN\_REG} = 4.3V$ and $V_{CHGIN\_UVLO} = 4.5V$ $0x01 = V_{CHGIN\_REG} = 4.7V$ and $V_{CHGIN\_UVLO} = 4.9V$ $0x02 = V_{CHGIN\_REG} = 4.8V$ and $V_{CHGIN\_UVLO} = 5.0V$ $0x03 = V_{CHGIN\_REG} = 4.9V$ and $V_{CHGIN\_UVLO} = 5.1V$
5	R/W	CHGINSEL	1	CHGIN/USB Input Channel Select 0 = Disabled 1 = Enabled
6	R/W	WCINSEL	1	WCIN Input Channel Select 0 = Disabled 1 = Enabled
7	R/W	Reserved	0	Reserved

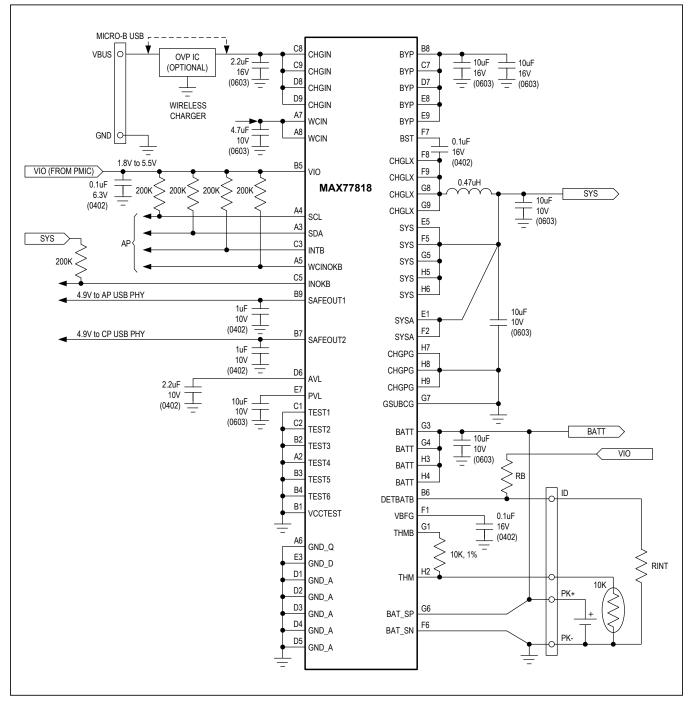
# Dual Input, Power Path, 3A Switching Mode Charger with FG

# PCB Layout Guide



## Dual Input, Power Path, 3A Switching Mode Charger with FG

## **Typical Application Circuit**



## Dual Input, Power Path, 3A Switching Mode Charger with FG

#### **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE
MAX77818EWZ+	-40°C to +85°C	72-pin WLP 0.4mm pitch, 3.867mm x 3.608mm (±0.015mm X and Y)

+Denotes lead(Pb)-free/RoHS-compliant package.

#### **Chip Information**

PROCESS: BICMOS

#### **Package Information**

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE	PACKAGE	OUTLINE	LAND
TYPE	CODE	NO.	PATTERN NO.
72 WLP	W723B3+1	<u>21-0477</u>	Refer to Application Note 1891

## Dual Input, Power Path, 3A Switching Mode Charger with FG

#### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	6/15	Initial release	—

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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